

ADS9813 18-Bit, 2MSPS, 8-Channel, Simultaneous-Sampling ADC With Integrated **Analog Front-End**

1 Features

- 8-channel, 18-bit ADC with analog front-end: Simultaneous sampling
 - Constant $1M\Omega$ input impedance front-end _
- Programmable analog input ranges:
 - ±12V, ±10V, ±7V, ±5V, ±3.5V, and ±2.5V
 - Single-ended and differential inputs
 - Common-mode voltage range: ±12V
 - Input overvoltage protection: Up to ±18V
- User-selectable analog input bandwidth:
 - 22.7kHz and 700kHz
- Integrated low-drift precision references:
 - ADC reference: 4.096V
 - 2.5V reference output for external circuits _
- Excellent AC and DC performance at fullthroughput:
 - DNL: ±0.35LSB, INL: ±0.8LSB
 - SNR: 90.3dBFS, THD: -113dB
- Power supply:
 - Analog and digital: 5V and 1.8V
 - Digital interface: 1.2V to 1.8V
- Temperature range: -40°C to +125°C

2 Applications

Bipolar

+12\

+10V

+7\/

-5\ _7V

Semiconductor test

Diffe

Programmable DC power supplies

Dynamic Input Signal Support AINXP and AINXM

Unipola

Multiple analog input

ranges

PGA

2.5

Parametric measurement units (PMU)

3 Description

The ADS9813 is an eight-channel data acquisition (DAQ) system based on a simultaneous sampling, 18bit successive approximation register (SAR) analogto-digital converter (ADC). The ADS9813 features a complete analog front-end (AFE) for each channel with an input clamp. The device also features a $1M\Omega$ input impedance and a programmable gain amplifier (PGA) with user-selectable bandwidth options. The high input impedance allows direct connection with sensors and transformers, thus eliminating the need for external driver circuits. Configure the ADS9813 to accept ±12V, ±10V, ±7V, ±5V, ±3.5V, and ±2.5V bipolar inputs with up to ±12V input common-mode voltage.

A digital interface supporting 1.2V to 1.8V operation enables the ADS9813 to be used without external voltage level translators.

Package Information

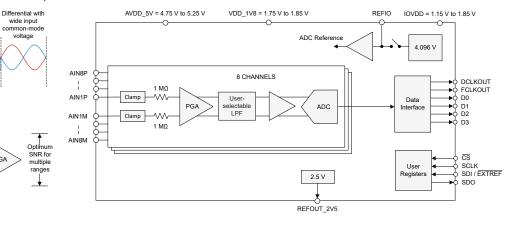
| PART NUMBER | PACKAGE ⁽¹⁾ | PACKAGE SIZE ⁽²⁾ | |
|------------------------------|------------------------|-----------------------------|--|
| ADS9813, ADS9811, ADS9810 | RSH (VQFN, 56) | 7mm × 7mm | |

(1)For more information, see the Mechanical, Packaging, and Orderable Information.

The package size (length × width) is a nominal value and (2)includes pins, where applicable.

Device Information

| PART NUMBER | SPEED | TOTAL POWER | | |
|------------------|---------------|-------------|--|--|
| ADS9813 | 2MSPS/channel | 244mW | | |
| ADS9811, ADS9810 | 1MSPS/channel | 177mW | | |



Device Block Diagram

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.



Table of Contents

| 1 | Features | .1 |
|---|--------------------------------------|-----|
| 2 | Applications | .1 |
| | Description | |
| 4 | Pin Configuration and Functions | .3 |
| 5 | Specifications | . 5 |
| | 5.1 Absolute Maximum Ratings | . 5 |
| | 5.2 ESD Ratings | . 5 |
| | 5.3 Recommended Operating Conditions | |
| | 5.4 Thermal Information | .6 |
| | 5.5 Electrical Characteristics | |
| | 5.6 Timing Requirements | 10 |
| | 5.7 Switching Characteristics | 11 |
| | 5.8 Timing Diagrams | 11 |
| | 5.9 Typical Characteristics | 14 |
| 6 | Detailed Description | 20 |
| | 6.1 Overview | 20 |
| | 6.2 Functional Block Diagram | 20 |
| | 6.3 Feature Description | 21 |
| | 6.4 Device Functional Modes | 31 |
| | | |

| 6.5 Programming | 33 |
|--|------|
| 7 Register Map | |
| 7.1 Register Bank 0 | |
| 7.2 Register Bank 1 | . 40 |
| 7.3 Register Bank 2 | |
| 8 Application and Implementation | 52 |
| 8.1 Application Information | |
| 8.2 Typical Application | |
| 8.3 Power Supply Recommendations | |
| 8.4 Layout | 56 |
| 9 Device and Documentation Support | 57 |
| 9.1 Receiving Notification of Documentation Updates. | |
| 9.2 Support Resources | 57 |
| 9.3 Trademarks | |
| 9.4 Electrostatic Discharge Caution | |
| 9.5 Glossary | |
| 10 Revision History | |
| 11 Mechanical, Packaging, and Orderable | |
| Information | . 57 |
| | |



4 Pin Configuration and Functions

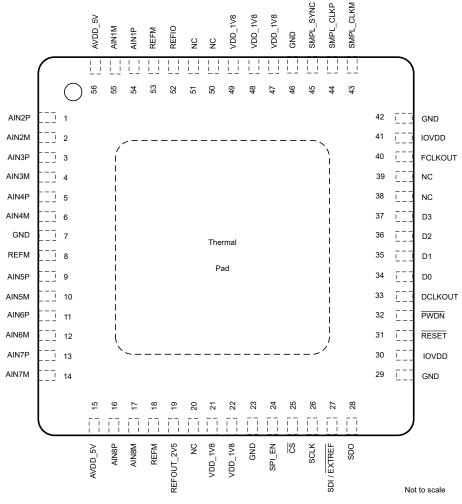


Figure 4-1. RSH Package, 56-Pin VQFN (Top View)

Table 4-1. Pin Functions

| PI | N | | DESCRIPTION |
|-------|-----|----|---|
| NAME | NO. | | DESCRIPTION |
| AIN1M | 55 | AI | Analog input channel 1, negative input. |
| AIN1P | 54 | AI | Analog input channel 1, positive input. |
| AIN2M | 2 | AI | Analog input channel 2, negative input. |
| AIN2P | 1 | AI | Analog input channel 2, positive input. |
| AIN3M | 4 | AI | Analog input channel 3, negative input. |
| AIN3P | 3 | AI | Analog input channel 3, positive input. |
| AIN4M | 6 | AI | Analog input channel 4, negative input. |
| AIN4P | 5 | AI | Analog input channel 4, positive input. |
| AIN5M | 10 | AI | Analog input channel 5, negative input. |
| AIN5P | 9 | AI | Analog input channel 5, positive input. |
| AIN6M | 12 | AI | Analog input channel 6, negative input. |
| AIN6P | 11 | AI | Analog input channel 6, positive input. |
| AIN7M | 14 | AI | Analog input channel 7, negative input. |
| AIN7P | 13 | AI | Analog input channel 7, positive input. |

Copyright © 2024 Texas Instruments Incorporated



Table 4-1. Pin Functions (continued)

| Р | IN | | | | |
|-------------|-----------------------|---------------------|---|--|--|
| NAME | NO. | TYPE ⁽¹⁾ | DESCRIPTION | | |
| AIN8M | 17 | AI | Analog input channel 8, negative input. | | |
| AIN8P | 16 | AI | Analog input channel 8, positive input. | | |
| AVDD_5V | 15, 56 | Р | 5V analog supply. Connect 1μF and 0.1μF decoupling capacitors to GND. | | |
| टड | 25 | DI | Chip-select input for the SPI interface configuration; active low. This pin has an internal $100k\Omega$ pullup resistor to IOVDD. | | |
| D0 | 34 | DO | Serial output data lane 0. | | |
| D1 | 35 | DO | Serial data output lane 1. | | |
| D2 | 36 | DO | Serial data output lane 2. | | |
| D3 | 37 | DO | Serial data output lane 3. | | |
| DCLKOUT | 33 | DO | Clock output for the data interface. | | |
| FCLKOUT | 40 | DO | Frame synchronization output for the data interface. | | |
| GND | 7, 23, 29, 42, 46 | Р | Ground. | | |
| IOVDD | 30, 41 | Р | Digital I/O supply for the data interface. Connect 1μ F and 0.1μ F decoupling capacitors to GND. | | |
| NC | 20, 38, 39, 50, 51 | _ | Not connected. No external connection. | | |
| PWDN | 32 | DI | Power-down control; active low. \overline{PWDN} has an internal 100k Ω pullup resistor to the digital interface supply. | | |
| REFIO | 52 | AI/AO | REFIO acts as an internal reference output when the internal reference is enabled. REFIO functions as an input pin for the external reference when the internal reference is disabled. Connect a 10μ F decoupling capacitor to the REFM pins. | | |
| REFM | 8, 18, 53 | AI | Reference ground potential. Connect to GND. | | |
| REFOUT_2V5 | 19 | AO | 2.5V reference output. Connect a decoupling 10µF capacitor to the REFM pins. | | |
| RESET | 31 | DI | Reset input for the device; active low. RESET has an internal $100k\Omega$ pullup resistor to the digital interface supply. | | |
| SCLK | 26 | DI | Serial clock input for the configuration interface. \overline{SCLK} has an internal 100k Ω pulldown resistor to the digital interface ground. | | |
| SDI/EXTREF | 27 | DI | SDI is a multifunction logic input. Pin function is determined by the SPI_EN pin. SDI has an internal $100k\Omega$ pulldown resistor to GND. SPI_EN = 0b: SDI is the logic input to select between the internal or external reference. Connect SDI to GND for the external reference. Connect SDI to IOVDD for the internal reference. SPI_EN = 1b: Serial data input for the configuration interface. | | |
| SDO | 28 | DO | Serial data output for the configuration interface. | | |
| SMPL_CLKM | 43 | DI | Connect SMPL_CLKM to GND for a single-ended ADC sampling clock input. SMPL_CLKM is the negative input for the differential sampling clock input to the ADC. | | |
| SMPL_CLKP | 44 | DI | Single-ended ADC sampling clock input. SMPL_CLKP is the positive input for the differential sampling clock input to the ADC. | | |
| SMPL_SYNC | 45 | DI | Synchronization input. See the <i>Synchronizing Multiple ADCs</i> section on how to use the SMPL_SYNC pin. | | |
| SPI_EN | 24 | DI | Logic input to enable the SPI interface configuration (\overline{CS} , SCLK, SDI, and SDO). SPI_EN has an internal 100k Ω pullup resistor to the digital interface supply. | | |
| VDD_1V8 | 21, 22, 47, 48, 49 | Р | 1.8V power-supply. Connect 1µF and 0.1µF decoupling capacitors to GND. | | |
| Thermal pad | | Р | Exposed thermal pad; connect to GND. | | |

(1) I = input, O = output, I/O = input or output, G = ground, and P = power.

Copyright © 2024 Texas Instruments Incorporated



5 Specifications

5.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT |
|--|------|-------|---------------|------|
| AVDD_5V to GND | | -0.3 | 6 | V |
| VDD_1V8 to GND | | -0.3 | 2.1 | V |
| IOVDD to GND | | -0.3 | 2.1 | V |
| AINxP and AINxM to GND | | -18 | 18 | V |
| REFIO to REFM | REFM | - 0.3 | AVDD_5V + 0.3 | V |
| REFM to GND | GND | - 0.3 | GND + 0.3 | V |
| Digital inputs to GND | GND | - 0.3 | 2.1 | V |
| Input current to any pin except supply pins ⁽²⁾ | | -10 | 10 | mA |
| Junction temperature, T _J | | -40 | 150 | °C |
| Storage temperature, T _{stg} | | -60 | 150 | °C |

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

(2) Limit pin current to 10mA or less.

5.2 ESD Ratings

| | | | VALUE | UNIT | |
|--------------------|-------------------------|---|-------|------|--|
| | | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾ | ±2000 | | |
| V _(ESD) | Electrostatic discharge | Charged device model (CDM), per JEDEC specification ANSI/ESDA/ JEDEC JS-002, all pins ⁽²⁾ | ±500 | V | |

(1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.



5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|---|--------------------|-------|-------|-------|------|
| POWER SU | PPLY | · · · | | | | |
| AVDD_5V | Analog power supply | AVDD_5V to GND | 4.75 | 5 | 5.25 | V |
| VDD_1V8 | Power supply | VDD_1V8 to GND | 1.75 | 1.8 | 1.85 | V |
| IOVDD | Digital interface power supply | IOVDD to GND | 1.15 | 1.8 | 1.85 | V |
| REFERENC | EVOLTAGE | · · · | | | 1 | |
| V _{REF} | Reference voltage to the ADC | External reference | 4.088 | 4.096 | 4.104 | V |
| ANALOG IN | IPUTS | · · · | | | | |
| V _{FSR} | | RANGE_CHx = 2 | -2.5 | | 2.5 | |
| | Full-scale input range | RANGE_CHx = 1 | -3.5 | | 3.5 | V |
| | | RANGE_CHx = 0 | -5 | | 5 | |
| | | RANGE_CHx = 3 | -7 | | 7 | |
| | | RANGE_CHx = 4 | -10 | | 10 | |
| | | RANGE_CHx = 5 | -12 | | 12 | |
| AINxP | Operating input voltage, positive input | AINxP to GND | -17 | | 17 | V |
| AINxM | Operating input voltage, negative input | AINxM to GND | -17 | | 17 | V |
| TEMPERAT | URE RANGE | · · · · | | | I | |
| T _A | Ambient temperature | | -40 | 25 | 125 | °C |

5.4 Thermal Information

| | | ADS981x | |
|-----------------------|--|------------|------|
| | THERMAL METRIC ⁽¹⁾ | RSH (VQFN) | UNIT |
| | | 56 PINS | |
| R _{θJA} | Junction-to-ambient thermal resistance | 23.2 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 10.5 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 6.1 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 0.1 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 6.0 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | 0.9 | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application note.



5.5 Electrical Characteristics

at AVDD_5V = 4.75V to 5.25V, VDD_1V8 = 1.75V to 1.85V, IOVDD = 1.15V to 1.85V, V_{REF} = 4.096V (external), and maximum throughput (unless otherwise noted); minimum and maximum values at T_A = -40°C to +125°C; typical values at T_A = 25°C

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|-------------------------------------|--|--------|--------|-------|--------|
| ANALOG | INPUTS | | | | | |
| R _{IN} | Input impedance | All input ranges | 0.8 | 1 | 1.2 | MΩ |
| | Input impedance thermal drift | All input ranges | | 10 | 30 | ppm/°C |
| | Input capacitance | | | 10 | | pF |
| ANALOG | INPUT FILTER | | | | I | |
| | | Low-bandwidth filter, all input ranges | | 22.7 | | |
| | | Wide-bandwidth filter, input range = ±2.5V | | 221 | | |
| | | Wide-bandwidth filter, input range = ±3.5V | | 325 | | |
| BW _(-3 dB) | Analog input LPF bandwidth –3 dB | Wide-bandwidth filter, input range = ±5V | | 500 | | kHz |
| | -5 00 | Wide-bandwidth filter, input range = ±7V | | 700 | | - |
| | | Wide-bandwidth filter, input range = ±10V | | 691 | | |
| | | Wide-bandwidth filter, input range = ±12V | | 664 | | |
| DC PERF | ORMANCE ^{(3) (4)} | | | | | |
| | Resolution | No missing codes | 18 | | | Bits |
| DNL | Differential nonlinearity | Wide CM enabled and disabled, all ranges | -0.99 | ±0.35 | 0.99 | LSB |
| INL | Integral nonlinearity | RANGE = $\pm 5V$ and $\pm 10V$, T _A = 20°C to 60°C, AVDD_5V = 4.9V to 5.1V ADS9813 and ADS9811 | -2 | ±0.8 | 2 | LSB |
| | | All ranges | -4 | ±0.8 | 4 | |
| | | RANGE = ±5V, ±10V, and ±12V | -75 | ±15 | 75 | |
| | 0.11 | RANGE = ±3.5V and ±7V | -100 | ±25 | 100 | |
| | Offset error | RANGE = ±2.5V | -175 | ±25 | 175 | LSB |
| | | All other conditions | | ±50 | | |
| | | All ranges, T _A = 0°C to 70°C | | 0.6 | 2 | |
| | Offset error thermal drift | All ranges | | 0.6 | | ppm/°C |
| | Gain error | All ranges | -0.038 | ±0.008 | 0.038 | %FSR |
| | | All ranges, T _A = 0°C to 70°C | | 0.6 | 3 | 10.0 |
| | Gain error thermal drift | All ranges | | 0.6 | | ppm/°C |



5.5 Electrical Characteristics (continued)

at AVDD_5V = 4.75V to 5.25V, VDD_1V8 = 1.75V to 1.85V, IOVDD = 1.15V to 1.85V, V_{REF} = 4.096V (external), and maximum throughput (unless otherwise noted); minimum and maximum values at T_A = -40°C to +125°C; typical values at T_A = 25°C

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------------|--|---|-------|-------|-----|--------|
| AC PERF | FORMANCE ⁽³⁾ (4) | | | | | |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = ±2.5V | 85.3 | 87.4 | | |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = ±3.5V | 86.3 | 88.4 | | |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = ±5V | 87 | 89.1 | | - |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = ±7V | 87.5 | 89.8 | | |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = ±10V | 88 | 90.2 | | |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = ±12V | 88.1 | 90.3 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±2.5V | 77.1 | 79.1 | | |
| SNR | Signal-to-noise ratio | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±3.5V | 77.4 | 79.4 | | dBFS |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±5V | 77.5 | 79.7 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±7V | 77.7 | 79.9 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±10V | 79.5 | 81.6 | | |
| | | Wide-bandwidth filter, f _{IN} = 2 kHz, range = ±12V | 80.2 | 82.4 | | |
| | | Low-noise filter, $f_{IN} = 2kHz$, range = $\pm 2.5V$ | 85.2 | 87.3 | | |
| | | Low-noise filter, f _{IN} = 2kHz, range = ±3.5V | 86.2 | 88.3 | | |
| | | Low-noise filter, f _{IN} = 2kHz, range = ±5V | 86.9 | 89 | | |
| | Signal-to-noise + distortion ratio | Low-noise filter, f _{IN} = 2kHz, range = ±7V | 87.4 | 89.7 | | dB |
| | | Low-noise filter, f _{IN} = 2kHz, range = ±10V | 87.9 | 90.1 | | |
| | | Low-noise filter, f _{IN} = 2kHz, range = ±12V | 88 | 90.2 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±2.5V | 77 | 79 | | |
| SINAD | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±3.5V | 77.3 | 79.3 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±5V | 77.4 | 79.6 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±7V | 77.6 | 79.8 | | |
| | | Wide-bandwidth filter, f _{IN} = 2kHz, range = ±10V | 79.4 | 81.5 | | |
| | | Wide-bandwidth filter, f _{IN} = 2 kHz, range = ±12V | 80.1 | 82.3 | | |
| THD | Total harmonic distortion | Low-noise filter, f _{IN} = 2kHz, all ranges | | -113 | | ЧĿ |
| עהו | | Wide-bandwidth filter, f _{IN} = 2kHz, all ranges | | -113 | | dB |
| SFDR | Spurious-free dynamic range | f _{IN} = 2kHz | | 102 | | ٦Ŀ |
| SFUR | Spunous-mee dynamic range | f _{IN} = 2kHz, <i>data averaging</i> enabled | | 113 | | dB |
| | CMRR | At dc | | -70 | | dB |
| | Isolation crosstalk | At dc | | -100 | | dB |
| NTERNA | AL REFERENCE | · | | | | |
| / _{REF} (1) | Voltage on REFIO pin (configured as output) | 1µF capacitor on REFIO pin, $T_A = 25^{\circ}C$ | 4.092 | 4.096 | 4.1 | V |
| | Reference temperature drift | | | 7 | 20 | ppm/°(|

Copyright © 2024 Texas Instruments Incorporated



5.5 Electrical Characteristics (continued)

at AVDD_5V = 4.75V to 5.25V, VDD_1V8 = 1.75V to 1.85V, IOVDD = 1.15V to 1.85V, V_{REF} = 4.096V (external), and maximum throughput (unless otherwise noted); minimum and maximum values at T_A = -40°C to +125°C; typical values at T_A = 25°C

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|------------------|----------------------------------|---|---------------|------|-----------|------|--|
| DIGITAL | INPUTS | | | | | | |
| V _{IL} | Input low logic level | | -0.3 | | 0.3 IOVDD | V | |
| VIH | Input high logic level | | 0.7 IOVDD | | IOVDD | V | |
| | Input capacitance | | | 6 | | pF | |
| LVDS SA | MPLING CLOCK INPUT | | | | I | | |
| | Lligh lovel input veltage (D M) | AC coupled | 100 | | | mV | |
| V _{TH} | High-level input voltage (P – M) | DC coupled | 300 | | | mv | |
| | Leveleveling to the set (D M) | AC coupled | | | -100 | | |
| V _{TL} | Low-level input voltage (P – M) | DC coupled | | | -300 | mV | |
| V _{ICM} | Input common-mode voltage | | 0.5 | 1.2 | 1.4 | V | |
| DIGITAL | OUTPUTS | | | | | | |
| V _{OL} | Output low logic level | I _{OL} = 200µA sink | 0 | | 0.2 IOVDD | V | |
| V _{OH} | Output high logic level | I _{OH} = 200μA source | 0.8 IOVDD | | IOVDD | V | |
| POWER | SUPPLY - ADS9813 | | | | t | | |
| | Total power dissipation | Maximum throughput | | 244 | 304 | mW | |
| | Supply surrent from AV(DD_E)/ | Maximum throughput, internal reference | | 28.3 | 32 | mA | |
| AVDD_5V | Supply current from AVDD_5V | Power-down | | 0.2 | 2 | mA | |
| | Supply surrent from V/DD 11/8 | Maximum throughput, internal reference | | 52 | 70 | | |
| VDD_1V8 | Supply current from VDD_1V8 | Power-down | | 0.2 | 8 | mA | |
| | Supply surrent from IOV/DD | Maximum throughput, C _L = 10pF | | 5 | 10 | mA | |
| IIOVDD | Supply current from IOVDD | Power-down | | 0.1 | 2 | ШA | |
| POWER | SUPPLY - ADS9811 and ADS9810 |) | | | · | | |
| | Total power dissipation | Maximum throughput | | 177 | 215 | mW | |
| | Supply current from AVDD_5V | Maximum throughput, internal reference | eference 21.3 | | 25 | | |
| AVDD_5V | Supply current from AVDD_5V | Power-down | | 0.2 | 2 | mA | |
| 1 | Supply current from VDD_1V8 | Maximum throughput, internal reference | | 35 | 43 | | |
| VDD_1V8 | Supply current from VDD_1V8 | Power-down | | 0.2 | 8 | mA | |
| | Supply current from IOVDD | Maximum throughput, C _L = 10pF | | 4 | 7 | | |
| IIOVDD | Supply current from IOVDD | ly current from IOVDD Power-down 0.1 | | 2 | mA | | |

(1) Does not include the variation in voltage resulting from solder shift effects.

(2) Measured with analog input common-mode voltage range ≤ ±RANGE/2 as described in Wide Common-Mode Configuration for Differential Inputs

(3) Minimum and maximum specifications are applicable for low-bandwidth filter setting.



5.6 Timing Requirements

at AVDD_5V = 4.75V to 5.25V, VDD_1V8 = 1.75V to 1.85V, IOVDD = 1.15V to 1.85V, V_{REF} = 4.096V (internal or external), and maximum throughput (unless otherwise noted); minimum and maximum values at T_A = -40°C to +125°C; typical values at T_A = 25°C

| | | | MIN | MAX | UNIT |
|--------------------------|------------------------------------|----------------------------|----------------------------|----------------------------|------------------|
| CONVERSION CY | 'CLE | | | | |
| f _{SMPL_CLK} | Sampling frequency | ADS9813 | 3.9 | 8.1 | MHz |
| f _{SMPL_CLK} | Sampling frequency | ADS9811 and ADS9810 | 3.9 | 4.1 | MHz |
| t _{SMPL_CLK} | Sampling time interval | • | 1 / f _{SMPL_CLK} | | ns |
| t _{PL_SMPL_CLK} | SMPL_CLK low time | | 0.45 t _{SMPL_CLK} | 0.55 t _{SMPL_CLK} | ns |
| t _{PH_SMPL_CLK} | SMPL_CLK high time | | 0.45 t _{SMPL_CLK} | 0.55 t _{SMPL_CLK} | ns |
| SPI INTERFACE T | IMINGS (CONFIGURATION INTE | RFACE) | | | |
| f _{SCLK} | Maximum SCLK frequency | | | 20 | MHz |
| t _{PH_CK} | SCLK high time | | 0.48 | 0.52 | t _{CLK} |
| t _{PL_CK} | SCLK low time | | 0.48 | 0.52 | t _{CLK} |
| t _{hi_CS} | Pulse duration: CS high | | 220 | | ns |
| t _{d_CSCK} | Delay time: CS falling to the firs | st SCLK capture edge | 20 | | ns |
| t _{su_CKDI} | Setup time: SDI data valid to th | e SCLK rising edge | 10 | | ns |
| t _{ht_CKDI} | Hold time: SCLK rising edge to | data valid on SDI | 5 | | ns |
| t _{D_CKCS} | Delay time: last SCLK falling to | 5 | | ns | |
| CMOS DATA INTE | RFACE | | | I | |
| t _{su_SS} | Setup time: SMPL_SYNC rising edge | g edge to SMPL_CLK falling | 10 | | ns |
| t _{ht_SS} | Hold time: SMPL_CLK falling e | dge to SMPL_SYNC high | 10 | | ns |

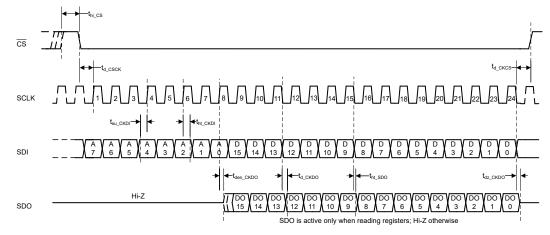


5.7 Switching Characteristics

at AVDD_5V = 4.75V to 5.25V, VDD_1V8 = 1.75V to 1.85V, IOVDD = 1.15V to 1.85V, V_{REF} = 4.096V (internal or external), and maximum throughput (unless otherwise noted); minimum and maximum values at T_A = -40°C to +125°C; typical values at T_A = 25°C

| | PARAMETER | TEST CONDITIONS | MIN | MAX | UNIT | |
|---------------------------|---|-----------------|-----------------------------|-----------------------------|-----------------------|--|
| RESET | | | | | | |
| t _{PU} | Power-up time for device | | | 30 | ms | |
| SPI INTERFA | CE TIMINGS (Configuration Interface) | | | | | |
| t _{den_CKDO} | Delay time: 8 th SCLK rising edge to data enable | | | 22 | ns | |
| t _{dz_CKDO} | Delay time: 24 th SCLK rising edge to SDO going Hi-Z | | | 50 | ns | |
| t _{d_СКDO} | Delay time: SCLK falling edge to corresponding data valid on SDO | | | 16 | ns | |
| t _{ht_CKDO} | Delay time: SCLK falling edge to previous data valid on SDO | | 2 | | ns | |
| CMOS DATA | INTERFACE | | | | | |
| • | Dete electrouteut | DDR mode | 10 | | | |
| t _{DCLK} | Data clock output | SDR mode | 20 | | ns | |
| | Clock duty cycle | | 45 | 55 | % | |
| t _{off_DCLKDO_r} | Time offset: DCLK rising to corresponding data valid | DDR mode | t _{DCLK} / 4 – 1.5 | t _{DCLK} / 4 + 1.5 | ns | |
| t _{off_DCLKDO_f} | Time offset: DCLK falling to corresponding data valid | DDR mode | t _{DCLK} / 4 – 1.5 | t _{DCLK} / 4 + 1.5 | ns | |
| t _{d_DCLKDO} | Time delay: DCLK rising to corresponding data valid | SDR mode | -1 | 1 | ns | |
| td_SYNC_FCLK | Time delay: SMPL_CLK falling edge with SYNC signal to corresponding FCLKOUT rising edge | | 3 | 4 | t _{SMPL_CLK} | |

5.8 Timing Diagrams





ADS9813, ADS9811, ADS9810 SBASAQ6A – JULY 2024 – REVISED NOVEMBER 2024

TEXAS INSTRUMENTS www.ti.com

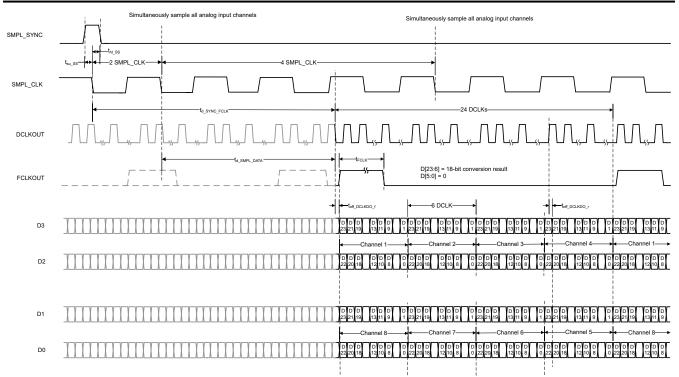


Figure 5-2. 4-SDO DDR CMOS Data Interface

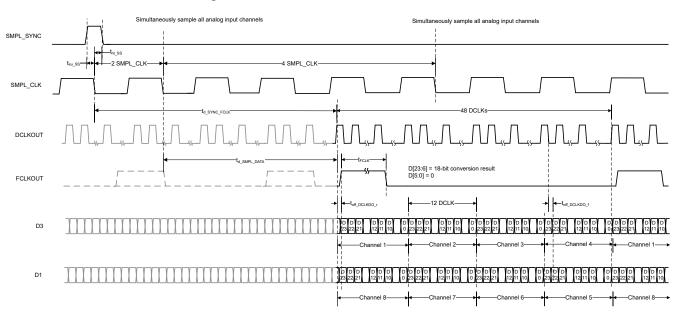
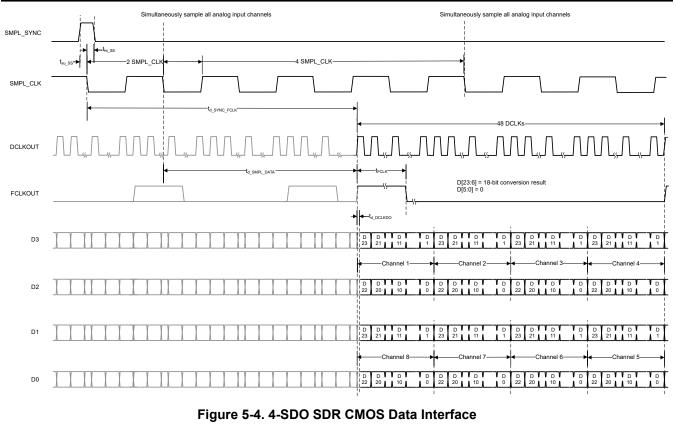
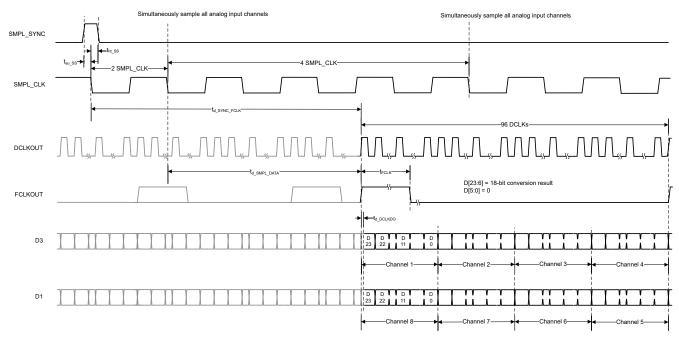


Figure 5-3. 2-SDO DDR CMOS Data Interface



ADS9813, ADS9811, ADS9810 SBASAQ6A – JULY 2024 – REVISED NOVEMBER 2024

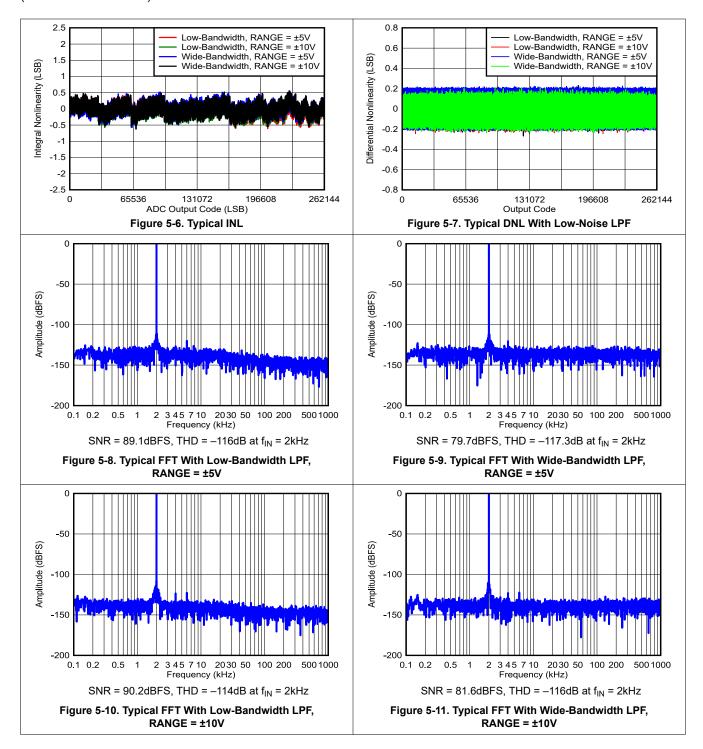




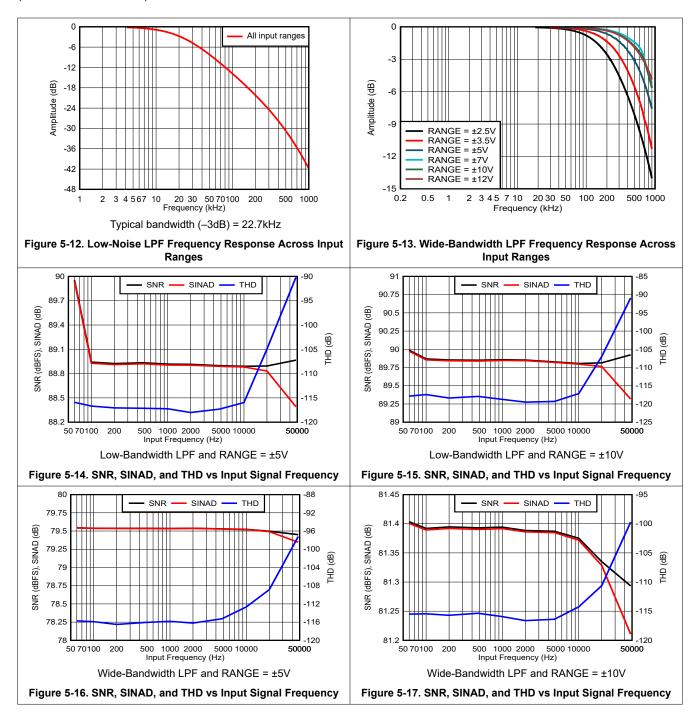




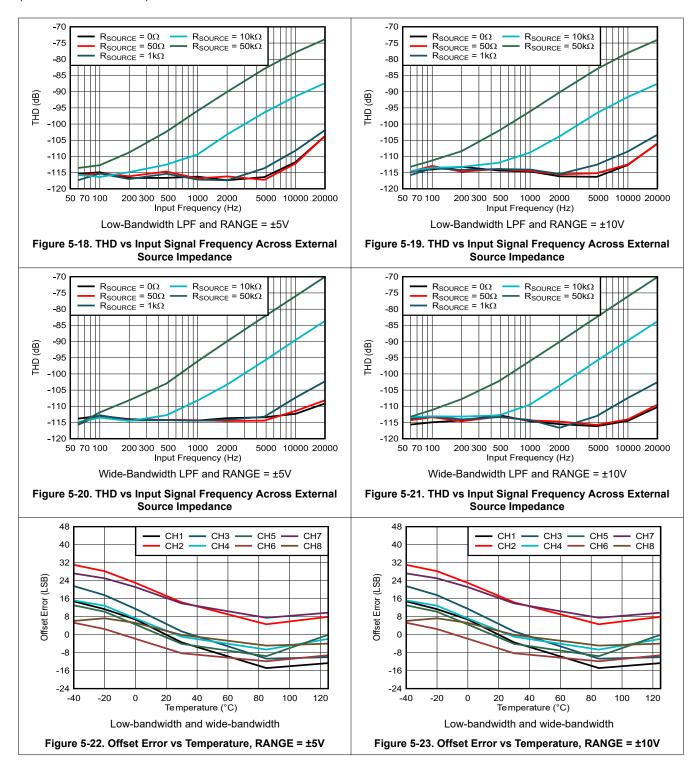
5.9 Typical Characteristics



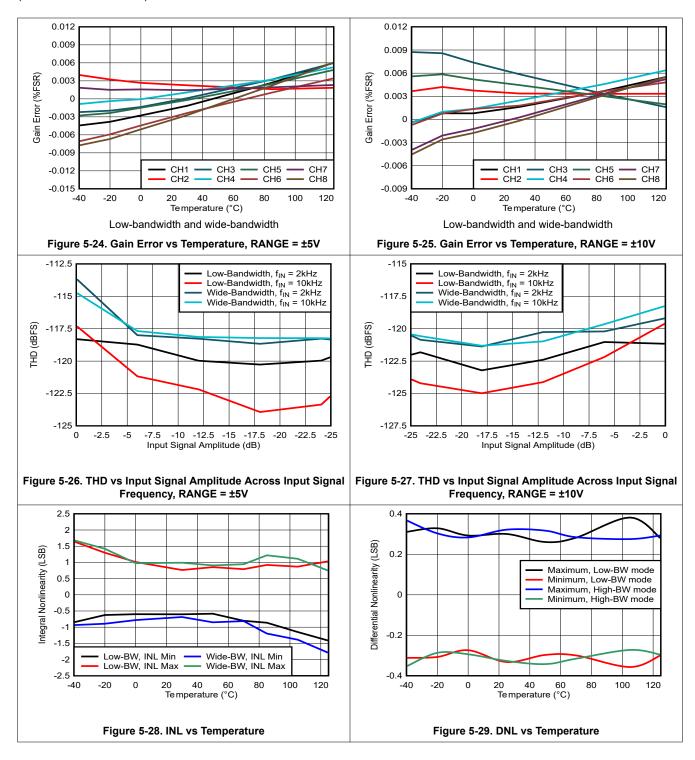




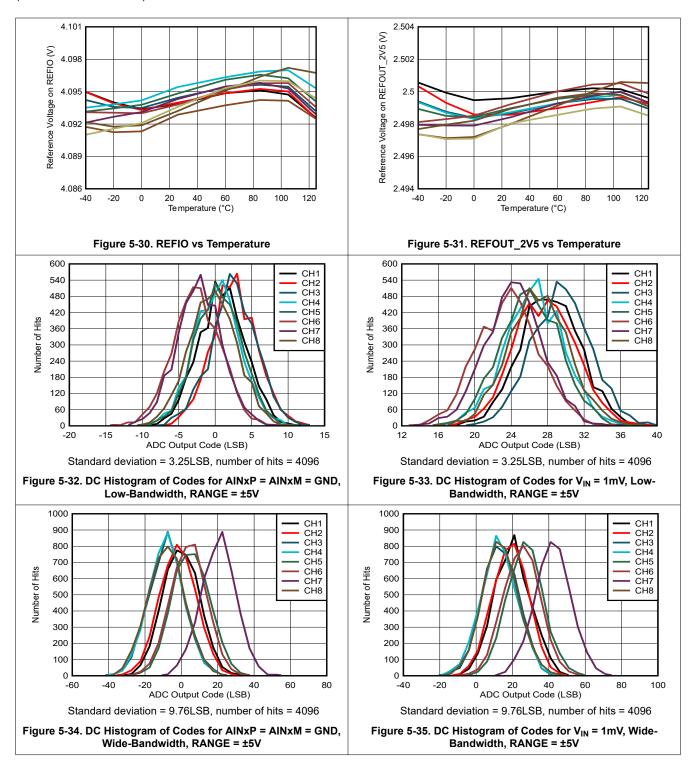




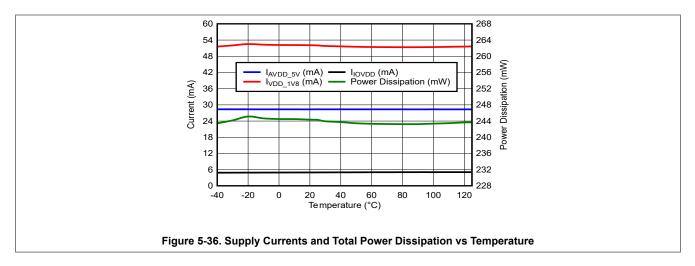












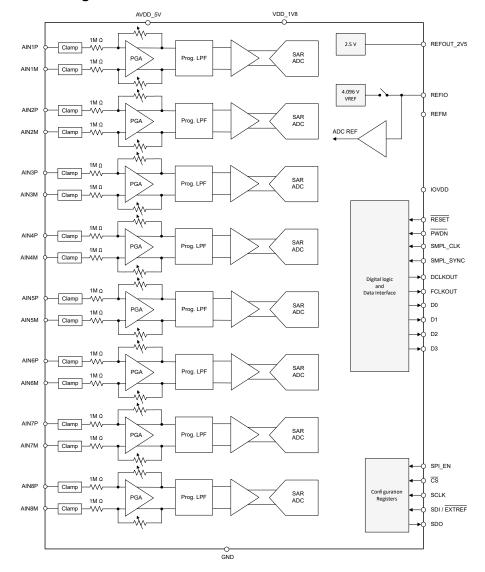


6 Detailed Description

6.1 Overview

The ADS9813 is an 18-bit data acquisition (DAQ) system with eight analog input channels configurable as either single-ended or differential. Each analog input channel consists of an input clamp protection circuit and a programmable gain amplifier (PGA) with user-selectable bandwidth options. The input signals are digitized with an 18-bit analog-to-digital converter (ADC), based on the successive approximation register (SAR) architecture. This overall system achieves a maximum throughput of 2MSPS per channel for all channels. The device has a 4.096V internal reference with several features that provide communication with a wide variety of digital hosts. These features include a fast-settling buffer, a programmable digital averaging filter to improve noise performance, and a high-speed data interface.

The device operates from 5V and 1.8V analog supplies and accommodates true bipolar input signals. The input clamp protection circuitry tolerates voltages up to $\pm 18V$. The device offers a constant $1M\Omega$ resistive input impedance irrespective of the sampling frequency or the selected input range. The ADS9813 offers a simplified end solution without requiring external high-voltage bipolar supplies and complicated driver circuits.



6.2 Functional Block Diagram



6.3 Feature Description

6.3.1 Analog Inputs

The ADS9813 incorporates eight, simultaneous sampling, 18-bit successive approximation register (SAR) analog-to-digital converters (ADCs). The device has a total of eight analog input pairs. The ADC digitizes the voltage difference between the analog input pairs AINxP – AINxM. Figure 6-1 shows the simplified circuit schematic for each analog input channel. This figure also shows the input clamp protection circuit, programmable gain amplifier (PGA), low-pass filter, high-speed ADC driver, and a precision 18-bit SAR ADC. Typical SNR for analog input ranges vs input common-mode ranges are shown in Table 6-5 for low-bandwidth mode.

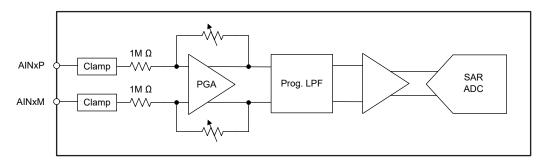


Figure 6-1. Front-End Circuit Schematic for the Selected Analog Input Channel

6.3.1.1 Input Clamp Protection Circuit

The ADS9813 features an internal clamp protection circuit (Figure 6-1) on each of the eight analog input channels. The input clamp protection circuit allows each analog input to swing up to a maximum voltage of $\pm 18V$. Beyond an input voltage of $\pm 18V$, the input clamp circuit turns on and still operates from the single 5V supply. Figure 6-2 shows a typical current versus voltage characteristic curve for the input clamp.

For input voltages above the clamp threshold, make sure that the input current never exceeds ±10mA. A resistor placed in series with the analog inputs is an effective way to limit the input current. In addition to limiting the input current, the series resistor also provides an antialiasing, low-pass filter (LPF) when coupled with a capacitor. Matching the external source impedance on the AINxP and AINxM pins cancels any additional offset error.



Figure 6-2. Input Protection Clamp Profile, Input Clamp Current vs Source Voltage



6.3.1.2 Programmable Gain Amplifier (PGA)

The ADS9813 features a PGA at every analog input channel. The PGA supports single-ended and differential inputs with a bipolar signal swing. Table 6-1 lists the supported analog input ranges. Configure the analog input range independently for each channel with the RANGE_CHx register fields in address 0xC2 and address 0xC3.

Table C 4 Analay Innut Danges

| DIFFERENTIAL INPUTS | SINGLE-ENDED INPUTS | RANGE_CHx CONFIGURATION |
|---------------------|---------------------|-------------------------|
| ±12V | ±12V | 5 |
| ±10V | ±10V | 4 |
| ±7V | ±7V | 3 |
| ±5V | ±5V | 0 |
| ±3.5V | ±3.5V | 1 |
| ±2.5V | ±2.5V | 2 |

Each analog input channel features an antialiasing, low-pass filter (LPF) at the output of the PGA. Table 6-2 lists the various programmable LPF options available in the ADS9813 corresponding to the analog input range. Figure 5-12 and Figure 5-13 illustrate the frequency responses for low-bandwidth and wide-bandwidth LPF configurations. Select the analog input bandwidth for the eight analog input channels with the ANA_BW[7:0] bits in address 0xC0 of register bank 1.

| LPF | ANALOG INPUT RANGE | CORNER FREQUENCY (-3dB) | | | | | |
|----------------|--------------------|-------------------------|--|--|--|--|--|
| Low-bandwidth | All input ranges | 22.7kHz | | | | | |
| | ±12V | 664kHz | | | | | |
| | ±10V | 691kHz | | | | | |
| Wide-bandwidth | ±7V | 700kHz | | | | | |
| wide-bandwidth | ±5V | 500kHz | | | | | |
| | ±3.5V | 325kHz | | | | | |
| | ±2.5V | 221kHz | | | | | |

Table 6-2. Low-Pass Filter Corner Frequency

6.3.1.3 Wide-Common-Mode Voltage Rejection Circuit

The ADS9813 features a common-mode (CM) rejection circuit at the analog inputs that supports CM voltages up to $\pm 12V$. The CM voltage for differential inputs is given by Equation 1. On power-up or after reset, the common-mode voltage range for the analog input channels is $\pm 12V$ (CM_CTRL_EN = 0b). In all cases, make sure the voltage at the analog inputs is within the *Absolute Maximum Ratings*.

$$Common mode voltage = \frac{(Voltage on AINP) + (Voltage on AINM)}{2}$$
(1)

As described in Table 6-3, optimize the CM voltage rejection circuit for various CM voltages for differential inputs.

Table 6-3. Wide Common-Mode Configuration for Differential Inputs

| COMMON-MODE | CM CTRL EN | ANALOG INPUT CHANNELS 1–4 | | ANALOG INPUT CHANNELS 5-8 | | |
|------------------------|------------|---------------------------|----------------|---------------------------|----------------|---|
| (CM) RANGE | | CM_EN_CH[4:1] | CM_RNG_CH[4:1] | CM_EN_CH[8:5] | CM_RNG_CH[8:5] | |
| CM ≤ ±1V | | 0 | Don't care | 0 | Don't care | |
| $CM \le \pm RANGE / 2$ | 1 | 4 | | 0 | | 0 |
| CM ≤ ±6V | | 1 | 1 | 1 | 1 | |
| CM ≤ ±12V | | | 2 | | 2 | |



The CM voltage rejection circuit is configured depending on the analog input range of the PGA when using single-ended inputs. Table 6-4 lists the recommended configuration for single-ended inputs for various analog input voltage ranges.

| PGA ANALOG | CM_CTRL_EN | ANALOG INPUT | CHANNELS 1-4 | ANALOG INPUT CHANNELS 5-8 | |
|--------------------------|------------|---------------|----------------|---------------------------|----------------|
| INPUT RANGE | | CM_EN_CH[4:1] | CM_RNG_CH[4:1] | CM_EN_CH[8:5] | CM_RNG_CH[8:5] |
| ±2.5V, ±3.5V, and ±5V | 1 | 0 | Don't care | 0 | Don't care |
| ±7V, ±10V, and ±12V | | 1 | 0 | 1 | 0 |

Table 6-4. Wide Common-Mode Configuration for Single-Ended Inputs

Typical SNR for analog input ranges vs input common-mode ranges are shown in Table 6-5 for low-bandwidth mode and Table 6-6 for wide-bandwidth mode.

Table 6-5. Typical SNR (dBFS) for Analog Input Range vs Common-Mode Range in Low-Bandwidth Mode

| RANGE | CM ≤ ±1V | CM ≤ ±RANGE / 2 | CM ≤ ±6V | CM ≤ ±12V |
|-------|----------|-----------------|----------|-----------|
| ±2.5V | 88.3 | 87.4 | 85.2 | 83.4 |
| ±3.5V | 88.3 | 88.4 | 87.0 | 85.4 |
| ±5V | 90.1 | 89.1 | 88.4 | 87.2 |
| ±7V | - | 89.8 | 89.4 | 88.5 |
| ±10V | - | 90.2 | 90.2 | 89.5 |
| ±12V | - | 90.3 | 90.3 | 89.9 |

Table 6-6. Typical SNR (dBFS) for Analog Input Range vs Common-Mode Range in Wide-Bandwidth Mode

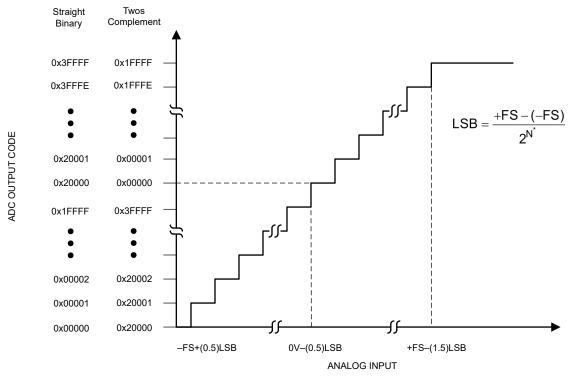
| RANGE | CM ≤ ±1V | CM ≤ ±RANGE / 2 | CM ≤ ±6V | CM ≤ ±12V | |
|-------|----------|-----------------|----------|-----------|--|
| ±2.5V | 80.5 | 79.1 | 76.7 | 74.7 | |
| ±3.5V | 81.1 | 79.4 | 77.6 | 75.8 | |
| ±5V | 81.6 | 79.7 | 78.4 | 76.7 | |
| ±7V | - | 80.0 | 79.2 | 77.5 | |
| ±10V | - | 81.6 | 81.2 | 79.7 | |
| ±12V | - | 82.4 | 82.4 | 80.9 | |

6.3.2 ADC Transfer Function

The ADS9813 outputs 18 bits of conversion data in either straight-binary or binary two's-complement formats. The format for the output codes is the same across all analog channels. Select the format for the output codes with the DATA_FORMAT register bits. Figure 6-3 and Table 6-7 show the transfer characteristics for the ADS9813. The LSB size depends on the analog input range selected.









| RANGE | +FS | MIDSCALE | –FS | LSB | | |
|-------|------|----------|-------|---------|--|--|
| ±2.5V | 2.5V | 0V | –2.5V | 19.07µV | | |
| ±3.5V | 3.5V | 0V | -3.5V | 26.70µV | | |
| ±5V | 5V | 0V | –5V | 38.15µV | | |
| ±7V | 7V | 0V | -7V | 53.41µV | | |
| ±10V | 10V | 0V | -10V | 76.29µV | | |
| ±12V | 12V | 0V | –12V | 91.55µV | | |

Copyright © 2024 Texas Instruments Incorporated



6.3.3 ADC Sampling Clock Input

Operate the ADS9813 with a differential or a single-ended clock input where the single-ended clock consumes less power consumption. Make sure the sampling clock is a free-running continuous clock. After a free-running sampling clock is applied, the ADC generates valid output data, the data clock, and the frame clock $t_{PU_SMPL_CLK}$. These parameters are specified in the *Switching Characteristics* section. The ADC output data, data clock, and frame clock are invalid when the sampling clock is stopped.

Figure 6-4 and Figure 6-5 show that the sampling clock is either differential or single-ended, respectively.

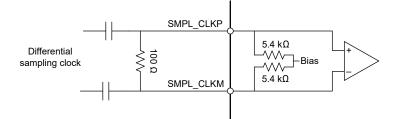


Figure 6-4. AC-Coupled Differential Sampling Clock

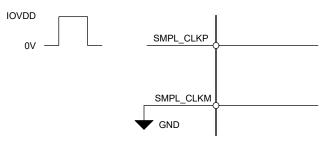


Figure 6-5. Single-Ended Sampling Clock

6.3.4 Synchronizing Multiple ADCs

Use the SMPL_SYNC signal to simultaneously sample all analog input channels of multiple ADS9813 devices. All ADS9813 devices share the same SMPL_CLK and SMPL_SYNC signals with identical delays external to the ADC. A positive pulse on the SMPL_SYNC pin centered around the falling edge of the SMPL_CLK signal synchronizes all ADCs; see Figure 5-2. The synchronization signal is only required one time after power-up with the sampling clock free-running, or after restarting sampling clock, or after a device reset. As illustrated in Figure 5-2, Figure 5-3, Figure 5-4, and Figure 5-5, the SYNC signal resets the internal analog channel selection logic and aligns the FCLKOUT signal to the data frame. If no SYNC signal is given, the internal analog channel selection logic and FCLKOUT are not synchronized, which can lead to a different alignment between the sequence of channel output data and FCLKOUT. When using multiple ADCs with the same sampling clock, the SYNC signal makes sure all ADCs sample the same respective analog input channel at the same time.



6.3.5 Reference Voltage

The ADS9813 has a precision, low-drift voltage reference internal to the device. For best performance, the internal reference noise is filtered (as shown in Figure 6-6) by connecting a 10μ F ceramic bypass capacitor to the REFIO pin. As shown in Figure 6-7, an external reference is also connected at the REFIO pin. When using an external reference, disable the internal reference voltage by either of the following two options:

- Configure the SPI (SPI EN pin = logic 1). Write PD REF = 1b in address 0xC1 of register bank 1.
- Use the SDI/EXTREF pin (SPI_EN pin = logic 0). Set the SDI/EXTREF pin to logic 0 using a pulldown resistor.

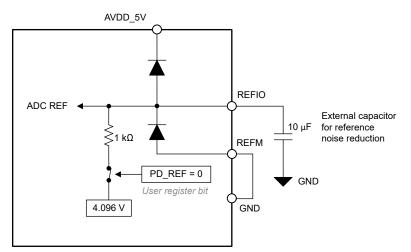


Figure 6-6. Internal Reference Voltage

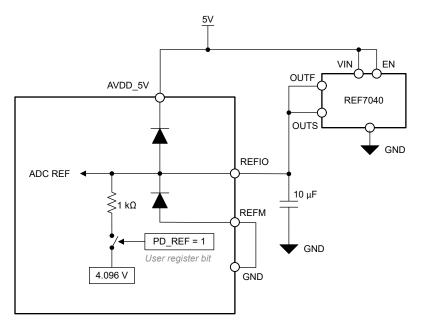


Figure 6-7. External Reference Voltage



6.3.6 Data Interface

The ADS9813 supports 2-lane and 4-lane mode with single-data-rate (SDR) and double-data-rate (DDR) interface modes. The data interface can be selected using the configuration SPI as described in Table 6-8. The ADC generates the data (D[3:0]), data clock (DCLKOUT), and frame clock (FCLKOUT) in response to the sampling clock signal on the SMPL_CLK input pin. The 18-bit ADC conversion result is output MSB first in a 24-bit data packet and the last six bits are zeroes.

The data interface signals can be described as:

- D[3:0]: Data output from the ADC. In 4-lane mode all four lanes are used, whereas in 2-lane mode D3 and D1 are used to output ADC data.
- DCLKOUT: Data clock output from the ADC.
- FCLKOUT: Frame clock output from the ADC delimiting each set of 8-channel data. A SYNC pulse is required on power-up or after device reset to align the rising edge of FCLKOUT with channel 1 data output, as described in the *Synchronizing Multiple ADCs* section.

Use the registers in Table 6-8 to configure the data interface.

| Table e el regioter comgatatorie i el mento | | | | | | |
|---|------------|-------------------------------|--------------------------------|--|--|--|
| INTERFACE MODE | FIGURE | DATA_RATE (Address = 0xC1) | DATA_LANES (Address = 0xC1) | | | |
| 4-lane, DDR | Figure 5-2 | 0 | 0 | | | |
| 2-lane, DDR | Figure 5-3 | 0 | 1 | | | |
| 4-lane, SDR | Figure 5-4 | 1 | 0 | | | |
| 2-lane, SDR | Figure 5-5 | 1 | 1 | | | |

Table 6-8. Register Configurations For Interface Modes

6.3.6.1 Data Clock Output

The ADS9813 features a source-synchronous data interface where the ADC provides the output data and the clock to capture the data. The clock to capture the data is output on the DCLKOUT pin. The clock frequency depends on the sampling clock speed, data rate (SDR or DDR), and number of output lanes (four lanes or two lanes) and is given by Equation 2. The frame clock frequency is given by Equation 3.

Data clock frequency =
$$\frac{24 \text{ bits/channel} \times 8 \text{ channels}}{\text{Number of data lanes} \times \text{ Data rate (SDR} = 1, \text{ DDR} = 2)} \times \text{Frame clock frequency}$$
 (2)
Frame clock frequency = $\frac{\text{Sampling clock frequency}}{4}$ (3)

Table 6-9 shows the data clock frequency for the maximum sampling rates for the ADS9817 and ADS9815 for various interface modes.

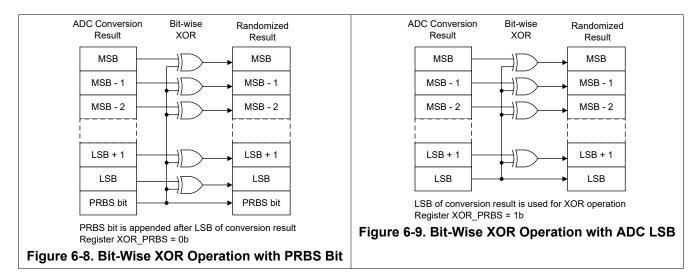
| INTERFACE MODE | ADS9815 (f _{SMPL_CLK} = 4MHz) | ADS9817 (f _{SMPL_CLK} = 8MHz) |
|----------------|---|---|
| 4-lane, DDR | 24MHz | 48MHz |
| 2-lane, DDR | 48MHz | 96MHz |
| 4-lane, SDR | 48MHz | 96MHz |
| 2-lane, SDR | 96MHz | Not supported |

Table 6-9. Data Clock Frequency for Interface Modes



6.3.6.2 ADC Output Data Randomizer

The ADS9813 features a data output randomizer. When enabled, the ADC conversion result is bit-wise exclusive-ORed (XOR) with either the LSB of the conversion result (Figure 6-9) or XOR_PRBS bit that can be appended to the ADC data output (Figure 6-8). The LSB of the ADC conversion result and XOR_PRBS have equal probability of being either 1 or 0. As a result of the XOR operation, the data output from the ADS9813 is randomized. The ground bounce created by the transmission of this randomized result over the data interface is uncorrelated with the analog input voltage. This uncorrelated transmission helps minimize interference between data transmission and analog performance of the ADC when the PCB layout does not minimize ground bounce.



6.3.6.3 Data Averaging

The ADS9813 features two modes of data averaging to improve SNR - simple average and moving average. Simple averaging reduces the output data rate by a factor of 2 whereas moving average does not affect the output data rate. Table 6-10 and Table 6-11 show the register operations to enable and disable the simple average and moving average respectively.

| STEP # | REGISTER FIELD | ENABLE SIMPLE AVERAGE | DISABLE SIMPLE AVERAGE | | |
|--------|----------------|-----------------------|------------------------|--|--|
| 1 | REG_BANK_SEL | 2 | 2 | | |
| 2 | EN_AVG | 1 | 0 | | |
| 3 | AVG_CFG3 | 1 | 0 | | |
| 4 | AVG_CFG2 | 3 | 0 | | |
| 5 | AVG_CFG1 | 1 | 0 | | |
| 6 | AVG_CFG4 | 3 | 0 | | |

Table 6-10. Register Operations for Simple Average

Table 6-11. Register Operations for Moving Average

| STEP # | REGISTER FIELD | ENABLE SIMPLE AVERAGE | DISABLE SIMPLE AVERAGE |
|--------|----------------|-----------------------|------------------------|
| 1 | REG_BANK_SEL | 2 | 2 |
| 2 | EN_AVG | 1 | 0 |
| 3 | EN_MVG_AVG | 1 | 0 |



6.3.6.4 Test Patterns for Data Interface

The ADS9813 features test patterns used by the host for debugging and verifying the data interface. The test patterns replace the ADC output data with predefined digital data. Enable the test patterns by configuring the corresponding register addresses 0x13 through 0x1B in bank 1.

Table 6-12 lists the test patterns supported by the ADS9813.

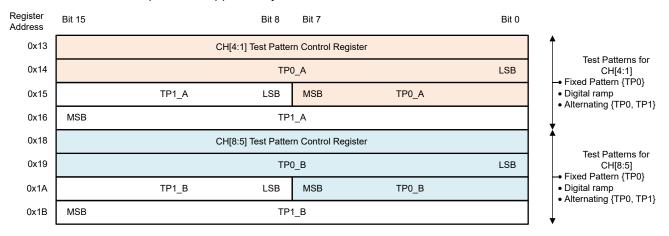


Figure 6-10. Register Bank for Test Patterns

Table 6-12. Test Pattern Configurations

| ADC OUTPUT | TP_EN_CH[4:1] TP_EN_CH[8:5] | TP_MODE_CH[4:1] TP_MODE_CH[8:5] | SECTION | RESULT1 |
|---------------------------|--------------------------------|------------------------------------|--------------------------|--|
| ADC conversion result | 0 | | | |
| Fixed pattern | 1 | 0 or 1 | Fixed Pattern | CH[4:1] = TP0_A CH[8:5] = TP0_B |
| Digital ramp | 1 | 2 | Digital Ramp | CH[4:1] = Digital ramp CH[8:5] = Digital ramp |
| Alternating test patterns | 1 | 3 | Alternating Test Pattern | CH[4:1] = TP0_A, TP1_A CH[8:5] = TP0_B, TP1_B |

Note

1. Configure the test patterns for two separate channel groups CH[4:1] and CH[8:5].

6.3.6.4.1 Fixed Pattern

The ADC outputs fixed patterns defined in the TP0_A and TP0_B registers in place of the CH[4:1] and CH[8:5] data, respectively.

- Configure the test patterns in TP0_A and TP0_B
- Set TP_EN_CH[4:1] = 1, TP_MODE_CH[4:1] = 0 (address = 0x13), TP_EN_CH[8:5] = 1, and TP_MODE_CH[8:5] = 0 (address = 0x18)

6.3.6.4.2 Digital Ramp

The ADC outputs digital ramp values with increments specified in the RAMP_INC_A and RAMP_INC_B registers in place of the CH[4:1] and CH[8:5] data, respectively.

- Configure the increment value between two successive steps of the digital ramp in the RAMP_INC_A (address = 0x13) and RAMP_INC_B (address = 0x18) registers, respectively. The digital ramp increments by N + 1, where N is the value configured in these registers.
- Set TP_EN_CH[4:1] = 1, TP_MODE_CH[4:1] = 2 (address = 0x13), TP_EN_CH[8:5] = 1, and TP_MODE_CH[8:5] = 2 (address = 0x18)

Copyright © 2024 Texas Instruments Incorporated



6.3.6.4.3 Alternating Test Pattern

The ADC outputs alternating test patterns defined in the TP0_A, TP1_A and TP0_B, TP1_B registers in place of the CH[4:1] and CH[8:5] data, respectively.

- Configure the test patterns in TP0_A, TP1_A, TP0_B, and TP1_B
- Set TP_EN_CH[4:1] = 1, TP_MODE_CH[4:1] = 3 (address = 0x13), TP_EN_CH[8:5] = 1, and TP_MODE_CH[8:5] = 3 (address = 0x18)



6.4 Device Functional Modes

6.4.1 Reset

Power down the ADS9813 with a logic 0 on the RESET pin or write 1b to the RESET field of address 0x00 in register bank 0. The device registers are initialized to the default values after reset and the device is initialized with a sequence of register write operations. See the *Initialization Sequence* section for further information.

6.4.2 Power-Down

Power down the ADS9813 with a logic 0 on the PWDN pin or write 11b to the PD_CH field in address 0xC0 in register bank 1. The device registers are initialized to the default values after power-up and the device is initialized with a sequence of register write operations. See the *Initialization Sequence* section for further information.

6.4.3 Initialization Sequence

As shown in Table 6-13, initialize the ADS9813 with a sequence of register writes after device power-up or reset. Connect a free-running sampling clock to the ADC before executing the initialization sequence. The ADS9813 registers are initialized with the default value after the initialization sequence is complete.

| STEP | | REGISTER | | COMMENT | |
|------|------|----------|-------------|-------------------------------------|--|
| SIEP | BANK | ADDRESS | VALUE[15:0] | COMMENT | |
| 1 | 0 | 0x04 | 0x000B | INIT_1 configured | |
| 2 | 0 | 0x03 | 0x0010 | Select register bank 2 | |
| 3 | 2 | 0x92 | 0x0002 | INIT_2 configured | |
| 3 | 2 | 0xC5 | 0x0604 | Initialize PGA and conifgure INIT_3 | |

Table 6-13. ADS9813 Initialization Sequence

As shown in Table 6-14, change the default settings of the ADS9813 for the user-defined configuration. Changes to the analog inputs changes the analog input range, bandwidth, and common-mode voltage range. Changes to the data interface change the number of output lanes (either single or double data rate).

| STEP | REGISTER | | | COMMENT | |
|------|----------|---------------|--------------|---|--|
| SIEP | BANK | ADDRESS | VALUE[15:0] | COMMENT | |
| 1 | 1 | 0xC1 | User defined | Configure data interface and select internal or external reference | |
| 2 | 1 | 0xC2 and 0xC3 | User defined | Select analog input ranges, see Table 6-1 | |
| 3 | 1 | 0xC0 | User defined | Select analog input bandwidth, see Table 6-2 | |
| 4 | 1 | 0xC4 and 0xC5 | User defined | Select common-mode range for analog inputs, see Table 6-3 and Table 6-4 | |

Table 6-14. ADS9813 User-Configuration

6.4.4 Normal Operation

After the ADS9813 is initialized (see the *Initialization Sequence* section), the ADS9813 converts analog input voltages to digital output voltages. A free-running sampling clock is required for normal device operation; see the *ADC Sampling Clock Input* section.



6.4.5 Speed-Boost Mode

ADS9813 supports a speed-boost mode that allows up to 8MSPS sampling rate for a user-selected analog input channel pair. In the speed-boost mode, only the user-selected channel pair is converted while the remaining 6 analog input channels are idle. The sampling rate is equal to the sampling clock frequency. The user can select any pair combination of analog inputs from the list below:

- CH1 and CH8
- CH2 and CH7
- CH3 and CH6
- CH4 and CH5

The data output interface specifications remain the same as normal mode of operation. CH[4:1] and CH[8:5] output data is replaced, respectively, by data corresponding to the channel pair selected.

Table 6-15 shows the register operations to enable or disable the speed-boost mode.

| STEP # | REGISTER FIELD | ENABLE SPEED-BOOST | DISABLE SPEED-BOOST |
|--------|----------------|--|---------------------|
| 1 | REG_BANK_SEL | 2 | 2 |
| 2 | BOOST_CFG1 | 3 | 0 |
| 3 | BOOST_CFG2 | 1 | 0 |
| 4 | EN_BOOST | 1 | 0 |
| 5 | SEL_CH_BOOST | 0 for CH1 and CH8 1 for CH2 and CH7 2 for CH3 and CH6 3 for CH4 and CH5 | 0 |
| 6 | REG_BANK_SEL | 16 | 16 |
| 7 | BOOST_CFG3 | 1 | 0 |
| 8 | BOOST_CFG4 | 1 | 0 |

Table 6-15. Register operations for Speed-Boost Mode



6.5 Programming

6.5.1 Register Write

Register write access is enabled by setting SPI_RD_EN = 0b. The 16-bit configuration registers are grouped in three register banks and are addressable with an 8-bit register address. Select register bank 1 and register bank 2 for read or write operation by configuring the REG_BANK_SEL bits. Registers in bank 0 are always accessible, irrespective of the REG_BANK_SEL bits. These register addresses are unique and are therefore not used in register banks 1 and 2.

As shown in Figure 6-11, steps to write to a register are:

- 1. Frame 1: Write to register address 0x03 in register bank 0 to select either register bank 1 or bank 2 for a subsequent register write. This frame has no effect when writing to registers in bank 0.
- 2. Frame 2: Write to the register in the bank selected in frame 1. Repeat this step for writing to multiple registers in the same register bank.

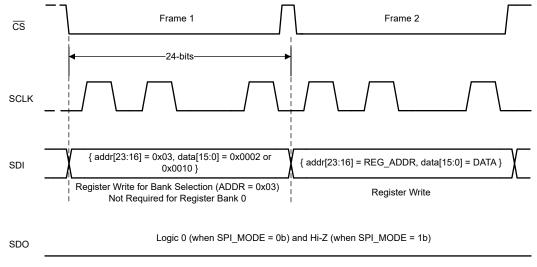


Figure 6-11. Register Write

6.5.2 Register Read

Select the desired register bank by writing to register address 0x03 in register bank 0. Register read access is enabled by setting SPI_RD_EN = 1b and SPI_MODE = 1b in register bank 0. As illustrated in Figure 6-12, read registers by using two 24-bit SPI frames after the SPI_RD_EN and SPI_MODE bits are set. The first SPI frame selects the register bank. The ADC returns the 16-bit register value in the second SPI frame corresponding to the 8-bit register address.

As illustrated in Figure 6-12, the steps to read a register are:

- 1. Frame 1: With SPI_RD_EN = 0b, write to register address 0x03 in register bank 0 to select the desired register bank 0 for reading.
- 2. Frame 2: Set SPI_RD_EN = 1b and SPI_MODE = 1b in register address 0x00 in register bank 0.
- 3. Frame 3: Read any register in the selected bank using a 24-bit SPI frame containing the desired register address. Repeat this step with the address of any register in the selected bank to read the corresponding register.
- 4. Frame 4: Set SPI_RD_EN = 0 to disable register read and re-enable register writes.
- 5. Repeat steps 1 through 4 to read registers in a different bank.

ADS9813, ADS9811, ADS9810 SBASAQ6A – JULY 2024 – REVISED NOVEMBER 2024

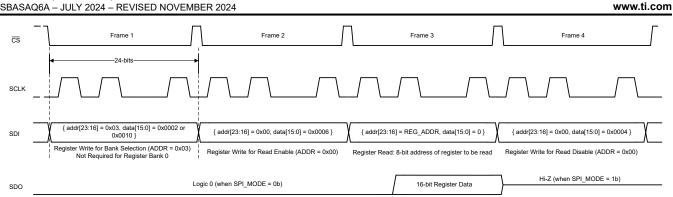


Figure 6-12. Register Read

6.5.3 Multiple Devices in a Daisy-Chain Topology for SPI Configuration

Figure 6-13 shows a typical connection diagram with multiple devices in a daisy-chain topology.

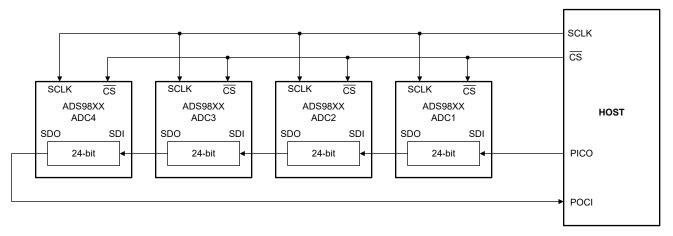


Figure 6-13. Daisy-Chain Connections for Configuration SPI

The \overline{CS} and SCLK inputs of all ADCs are connected together and controlled by a single \overline{CS} and SCLK pin of the controller, respectively. The SDI input pin of the first ADC in the chain (ADC1) is connected to the peripheral IN controller OUT (PICO) pin of the controller. Then, the SDO output pin of ADC1 is connected to the SDI input pin of ADC2, and so on. The SDO output pin of the last ADC in the chain (ADC4) is connected to the peripheral OUT controller IN (POCI) pin of the controller. The data on the PICO pin passes through ADC1 with a 24-SCLK delay, as long as \overline{CS} is active.

Enable daisy-chain after power-up or after the device is reset. Set the daisy-chain length in the DAISY_CHAIN_LEN register to enable daisy-chain mode. The daisy-chain length is the number of ADCs in the chain excluding ADC1. In Figure 6-13, the DAISY_CHAIN_LEN is 3.

FXΔS

INSTRUMENTS



6.5.3.1 Register Write With Daisy-Chain

Writing to registers in daisy-chain requires N \times 24 SCLKs in one SPI frame. As depicted in Figure 6-13, a register write operation in a daisy-chain containing four ADCs requires 96 SCLKs.

Daisy-chain mode is enabled on power-up or after device reset. Configure the DAISY_CHAIN_LEN field to enable daisy-chain mode. Repeat the waveform shown in Figure 6-14 N times, where N is the number of ADCs in daisy-chain. Figure 6-15 provides the SPI waveform, containing N SPI frames, for enabling daisy-chain mode for N ADCs.

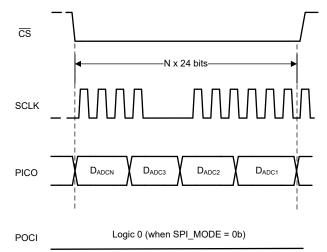


Figure 6-14. Register Write With Daisy-Chain

 $D_{ADC1}[23:0] = D_{ADC2}[23:0] = D_{ADC3}[23:0] = D_{ADCN}[23:0] = \{0000\ 0001,\ 0000\ 0000,\ N-1,\ 00\}$

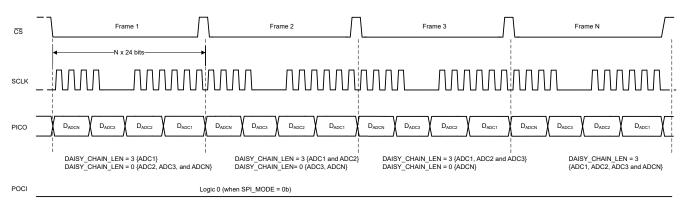


Figure 6-15. Register Write to Configure the Daisy-Chain Length



6.5.3.2 Register Read With Daisy-Chain

Figure 6-16 depicts an SPI waveform for reading registers in daisy-chain. Steps for reading registers from N ADCs connected in daisy-chain are:

- 1. A register read is enabled by writing to the following registers using the *register write with daisy-chain operation*:
 - a. Write to REG_BANK_SEL to select the desired register bank
 - b. Enable register reads by writing SPI_RD_EN = 0b (default on power-up)
- 2. With the register bank selected and SPI_RD_EN = 0b, the controller reads register data in the following two steps:
 - a. The N × 24-bit SPI frame containing the 8-bit register address is read: N-times {0xFE, 0x00, 8-bit register address}
 - b. The N × 24-bit SPI frame to read out register data is read: N-times {0xFF, 0xFF, 0xFF}

The 0xFE in step 2a configures the ADC for register reads from the specified 8-bit address. At the end of step 2a, the output shift register in the ADC is loaded with register data. The ADC returns the 8-bit register address and corresponding 16-bit register data in step 2b.

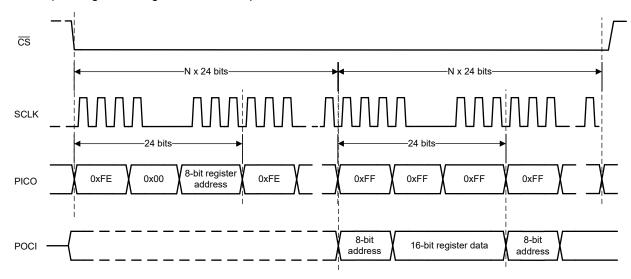


Figure 6-16. Register Read With Daisy-Chain



7 Register Map

7.1 Register Bank 0

| | Figure 7-1. Register Bank 0 Map | | | | | | | | | | | | | | | |
|-----|---------------------------------|------------------|-----|-----|-----|-----|----|----|----|-----------------|----|----|------|------|----|----|
| ADD | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 00h | RESERVED SPI_MO SPI_RD RESET | | | | | | | | | RESET | | | | | | |
| 01h | RESERVED | | | | | | | | | DAISY_CHAIN_LEN | | | RESE | RVED | | |
| 03h | RESERVED REG_BANK_SEL | | | | | | | | | | | | | | | |
| 04h | RESERVED INIT_1 | | | | | | | | | | | | | | | |
| 06h | | REG_00H_READBACK | | | | | | | | | | | | | | |

Table 7-1. Register Section/Block Access Type Codes

| Access Type Code | | Description | | |
|---|-----|--|--|--|
| R | R | Read | | |
| W | W | Write | | |
| R/W | R/W | Read or write | | |
| Reset or Default Value | | | | |
| -n Value after reset or the default value | | Value after reset or the default value | | |

7.1.1 Register 00h (offset = 0h) [reset = 0h]

| | Figure 7-2. Register 00h | | | | | | | | | | |
|------|--------------------------|----------|----------|-----------|-------|------|------|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED | | | | | | | | | | |
| W-0h | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | | RESERVED | SPI_MODE | SPI_RD_EN | RESET | | | | | | |
| | | W-0h | | | W-0h | W-0h | W-0h | | | | |

Figure 7-3. Register 00h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------|------|-------|--|
| 15-3 | RESERVED | W | 0h | Reserved. Do not change from the default reset value. |
| 2 | SPI_MODE | W | 0h | Select between legacy SPI mode and daisy-chain SPI mode for the configuration interface for register access. 0 : Daisy-chain SPI mode 1 : Legacy SPI mode |
| 1 | SPI_RD_EN | W | 0h | Enable register read access in legacy SPI mode. This bit has no effect in daisy-chain SPI mode. 0 : Register read disabled 1 : Register read enabled |
| 0 | RESET | W | 0h | ADC reset control. 0 : Normal device operation 1 : Reset ADC and all registers |



7.1.2 Register 01h (offset = 1h) [reset = 0h]

| | Figure 7-4. Register 01h | | | | | | | | | | |
|----------|--------------------------|---------------|--------|----|----|-----|------|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED | | | | | | | | | | |
| | R/W-0h | | | | | | | | | | |
| 7 | 6 | 6 5 4 3 2 1 0 | | | | | | | | | |
| RESERVED | DAISY_CHAIN_LEN RESERVED | | | | | | | | | | |
| R/W-0h | | | R/W-0h | | | R/W | /-0h | | | | |

Figure 7-5. Register 01h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|-------|--|
| 15-7 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 6-2 | DAISY_CHAIN_L EN | R/W | 0h | Number of ADCs connected in SPI daisy-chain 0 : 1 ADC 1 : 2 ADCs 31 : 32 ADCs |
| 1-0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |

7.1.3 Register 03h (offset = 3h) [reset = 2h]

| Figure 7-6. Register 03h | | | | | | | | | | |
|--------------------------|-----------------|----|-----|------|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | RESERVED | | | | | | | | | |
| | R/W-0h | | | | | | | | | |
| 7 | 7 6 5 4 3 2 1 0 | | | | | | | | | |
| | REG_BANK_SEL | | | | | | | | | |
| | | | R/W | /-2h | | | | | | |

Figure 7-7. Register 03h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------|------|-------|---|
| 15-8 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 7-0 | REG_BANK_SEL | R/W | 1 '2n | Register bank selection for read and write operations. 0 : Select register bank 0 2 : Select register bank 1 16 : Select register bank 2 |



7.1.4 Register 04h (offset = 4h) [reset = 0h]

| | Figure 7-8. Register 04h | | | | | | | | | | |
|----|--------------------------|------|----|--------|----|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED | | | | | | | | | | |
| | R/W-0h | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | RESE | RVED | • | INIT_1 | | | | | | | |
| | R/V | V-0h | | R/W-0h | | | | | | | |

Figure 7-9. Register 04h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------|------|-------|---|
| 15-4 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 3-0 | INIT_1 | R/W | 0h | Set to 0011b for normal operation. Refer to section on <i>Initialization Sequence</i> for more details. |

7.1.5 Register 06h (offset = 6h) [reset = 2h]

| Figure 7-10. Register 06h | | | | | | | | | | |
|---------------------------|------------------|----|----|----|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | REG_00H_READBACK | | | | | | | | | |
| R-0h | | | | | | | | | | |
| 7 | 7 6 5 4 3 2 1 0 | | | | | | | | | |
| REG_00H_READBACK | | | | | | | | | | |
| | | | R- | 5h | | | | | | |

Figure 7-11. Register 06h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------|------|-------|--|
| 15-0 | REG_00H_READ BACK | R | 2h | This register is a copy of the register address 0x00 for readback. |



7.2 Register Bank 1

| | | | | | F | igure | 7-12. F | Registe | er Ban | k 1 Ma | р | | | | | |
|-----|---------------------|-------------------------------|-------|----------|---------|---------------------|----------------|---------------|-----------------------|-----------|-------|----------------|-------------------|-------------------|----------------|--------------|
| ADD | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0Dh | RESE | RESERVED DATA_FORMAT RESERVED | | | | | 1 | | EN_AVG | | l | RESERVE |) | | EN_MV G_AVG | |
| 12h | | | | | | RESERVE |) | | | | | XOR_ PRBS | XOR_EN | F | RESERVE | D |
| 13h | | | | RESE | RVED | | | | | RAMP_ | INC_A | | TP_M | DDE_A | TP_EN_ A | RESERV ED |
| 14h | | | | | | | | TP | 0_A | | | | | | | |
| 15h | TP1_A | | | | | | | | | | TP | 0_A | | | | |
| 16h | | | | | | | | TP | 1_A | | | | | | | |
| 18h | RESERVED | | | | | | | | RAMP_ | INC_B | | TP_M | DDE_B | TP_EN_ B | RESERV ED | |
| 19h | | | | | | | | TP | 0_В | | | | | | | |
| 1Ah | TP1_B | | | | | | | | | | TP | 0_В | | | | |
| 1Bh | | | | | | | | TP | 1_B | | | | | | | |
| 1Ch | RESE | RVED | | | USER_BI | FS_CH[8:5] | | | RESE | RVED | | | USER_BIT | S_CH[4:1] | | |
| 37h | | | | | | I | RESERVEI | C | | | | | | BOOST_ | CH_SEL | EN_ BOOST |
| 3Ch | | | | RESE | RVED | | | | AVG_ CFG3 RESERVED | | | | | | | |
| 92h | | | | | | | RESE | RVED | | | | | | | INIT_2 | RESERV ED |
| C0h | | | RESE | RVED | | | | | ANA_BW PD_C | | | | СН | | | |
| C1h | | RESE | ERVED | | PD_REF | RESERV ED | DATA_ LANES | DATA_ RATE | | | | RESE | RVED | | | |
| C2h | RANGE_CH4 RANGE_CH3 | | | | | RANGE_CH2 RANGE | | | | E_CH1 | | | | | | |
| C3h | RANGE_CH8 RANGE_CH7 | | | | | RANGE_CH6 RANGE_CH5 | | | | | | | | | | |
| C4h | | | RESE | RVED | · | | CM_RNG | G_CH[8:5] | CM_RNC | G_CH[4:1] | AVG_0 | CFG2 | CM_EN_ CH[8:5] | CM_EN_ CH[4:1] | AVG_ CFG1 | PD_ CHIP |
| C5h | BOOST | _CFG1 | F | RESERVED |) | INIT_3 | PGA_ IN1T2 | RESE | RVED | AVG_ | CFG4 | CM_CT RL_EN | BOOST_ CFG2 | PGA_ IN1T1 | RESE | RVED |

Table 7-2. Register Section/Block Access Type Codes

| Access Type | Code | Description | | | | | |
|------------------------|------------------------|--|--|--|--|--|--|
| Access Type | | Description | | | | | |
| R | R | Read | | | | | |
| W | W | Write | | | | | |
| R/W | R/W | Read or write | | | | | |
| Reset or Default Value | Reset or Default Value | | | | | | |
| -n | | Value after reset or the default value | | | | | |



7.2.1 Register 0Dh (offset = Dh) [reset = 2002h]

| | | | i igule /-15. | Register UDII | | | | |
|----------|--------|---------------------|---------------|---------------|----|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESERVED | | DATA_FORMAT | RESERVED | | | | | |
| R/W-0h | | R/W-1h | R/W-0h | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESERVED | EN_AVG | RESERVED EN_MVG_AVG | | | | | | |
| R/W-0h | R/W-0h | | R/W-1h R/W-0h | | | | | |

Figure 7-13. Register 0Dh

Figure 7-14. Register 0Dh Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------|------|-------|--|
| 15-14 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 13 | DATA_FORMAT | R/W | 1h | Select data format for the ADC conversion result. 0 : Straight binary format 1 : Two's-complement format |
| 12-7 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 6 | EN_AVG | R/W | 0h | Set 1b to enable data averaging. See Table 6-10 and Table 6-11 for more details. |
| 5-1 | RESERVED | R/W | 1h | Reserved. Do not change from the default reset value. |
| 0 | EN_MVG_AVG | R/W | 0h | Set 1b to enable moving data average. See Table 6-11 for more details. |

Register 12h (offset = 12h) [reset = 2h]

| | Figure 7-15. Register 12h | | | | | | | | | | |
|----|---------------------------|----|--------|--------|----------|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED | | | | | | | | | | |
| | R/W-0h | | | | | | | | | | |
| 7 | 7 6 5 | | 4 | 3 | 2 | 1 | 0 | | | | |
| | RESERVED | | | XOR_EN | RESERVED | | | | | | |
| | R/W-0h | | R/W-0h | R/W-0h | R/W-2h | | | | | | |

Figure 7-16. Register 12h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------|------|-------|---|
| 15-5 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 4 | XOR_PRBS | R/W | 0h | Select bit for XOR operation when XOR_EN = 1b. 0 : PRBS is appended after the LSB of the ADC conversion result. The ADC conversion result is bit-wise XOR with the PRBS bit. 1 : The ADC conversion result is bit-wise XOR with the LSB of the ADC conversion result. |
| 3 | XOR_EN | R/W | Oh | Enables XOR operation on the ADC conversion result. 0 : XOR operation is disabled 1 : Bit-wise XOR operation on ADC conversion result is enabled |
| 2-0 | RESERVED | R/W | 2h | Reserved. Do not change from the default reset value. |

Copyright © 2024 Texas Instruments Incorporated



7.2.2 Register 13h (offset = 13h) [reset = 0h]

| | Figure 7-17. Register 13h | | | | | | | | | | |
|----|---------------------------|-------|----|---------------|-------|---------|----------|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED | | | | | | | | | | |
| | R/W-0h | | | | | | | | | | |
| 7 | 7 6 5 4 | | | | 2 | 1 | 0 | | | | |
| | RAMP | INC_A | | TP_M0 | DDE_A | TP_EN_A | RESERVED | | | | |
| | R/W | V-0h | | R/W-0h R/W-0h | | | R/W-0h | | | | |

Figure 7-18. Register 13h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------|------|-------|---|
| 15-8 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 7-4 | RAMP_INC_A | R/W | 0h | Increment value for the ramp pattern output. The output ramp increments by N+1, where N is the value configured in this register. |
| 3-2 | TP_MODE_A | R/W | Oh | Select digital test pattern for analog input channels 1, 2, 3, and 4. 0 : Fixed pattern from the TP0_A register 1 : Fixed pattern from the TP0_A register 2 : Digital ramp output 3 : Alternate fixed pattern output from the TP0_A and TP1_A registers |
| 1 | TP_EN_A | R/W | 0h | Enable digital test pattern for data corresponding to channels 1, 2, 3, and 4. 0 : Data output is the ADC conversion result 1 : Data output is the digital test pattern for channels 1, 2, 3, and 4 |
| 0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |

7.2.3 Register 14h (offset = 14h) [reset = 0h]

| | Figure 7-19. Register 14h | | | | | | | | | | |
|----|---------------------------|----|-----|------|----|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | TP0_A[15:0] | | | | | | | | | | |
| | R/W-0h | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | TP0_A[15:0] | | | | | | | | | | |
| | | | R/W | /-0h | | | | | | | |

Figure 7-20. Register 14h Field Descriptions

| Bit | Field | Туре | Reset | Description | | | | | | | |
|------|-------------|------|-------|---------------------------------|--|--|--|--|--|--|--|
| 15-0 | TP0_A[15:0] | R/W | 0h | Lower 16 bits of test pattern 0 | | | | | | | |



7.2.4 Register 15h (offset = 15h) [reset = 0h]

| | Figure 7-21. Register 15h | | | | | | | | | | |
|--------------|---------------------------|----|-----|------|----|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| TP1_A[7:0] | | | | | | | | | | | |
| R/W-0h | | | | | | | | | | | |
| 7 | 7 6 5 4 3 2 1 0 | | | | | | | | | | |
| TP0_A[23:16] | | | | | | | | | | | |
| | | | R/W | /-0h | | | | | | | |

Figure 7-22. Register 15h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------|------|-------|------------------------------------|
| 15-8 | TP1_A[7:0] | R/W | 0h | Lower eight bits of test pattern 1 |
| 7-0 | TP0_A[23:16] | R/W | 0h | Upper eight bits of test pattern 0 |

7.2.5 Register 16h (offset = 16h) [reset = 0h]

| | Figure 7-23. Register 16h | | | | | | | | |
|----|---------------------------|----|-----|------|----|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | TP1_A[23:8] | | | | | | | | |
| | R/W-0h | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | TP1_A[23:8] | | | | | | | | |
| | | | R/W | /-0h | | | | | |

Figure 7-24. Register 16h Field Descriptions

| Bit | Field | Туре | Reset | Description | | | | |
|------|-------------|------|-------|---------------------------------|--|--|--|--|
| 15-0 | TP1_A[23:8] | R/W | 0h | Upper 16 bits of test pattern 1 | | | | |



7.2.6 Register 18h (offset = 18h) [reset = 0h]

| | Figure 7-25. Register 18h | | | | | | | |
|----|---------------------------|-------|----|---------------------|-------|---------|----------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | RESERVED | | | | | | | |
| | R/W-0h | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | RAMP | INC_B | • | TP_MC | DDE_B | TP_EN_B | RESERVED | |
| | R/W | /-0h | | R/W-0h R/W-0h R/W-0 | | | R/W-0h | |

Figure 7-26. Register 18h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------|------|-------|---|
| 15-8 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 7-4 | RAMP_INC_B | R/W | 0h | Increment value for the ramp pattern output. The output ramp increments by N+1, where N is the value configured in this register. |
| 3-2 | TP_MODE_B | R/W | Oh | Select digital test pattern for analog input channels 5, 6, 7, and 8. 0 : Fixed pattern from the TP0_B register 1 : Fixed pattern from the TP0_B register 2 : Digital ramp output 3 : Alternate fixed pattern output from the TP0_B and TP1_B registers |
| 1 | TP_EN_B | R/W | 0h | Enable digital test pattern for data corresponding to channels 5, 6, 7, and 8. 0 : Data output is the ADC conversion result 1 : Data output is the digital test pattern |
| 0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |

7.2.7 Register 19h (offset = 19h) [reset = 0h]

Figure 7-27. Register 19h

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
|----|-------------|----|-----|------|----|---|---|--|--|
| | TP0_B[15:0] | | | | | | | | |
| | R/W-0h | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | TP0_B[15:0] | | | | | | | | |
| | | | R/W | /-0h | | | | | |

Figure 7-28. Register 19h Field Descriptions

| Bit | Field | Туре | Reset | Description | | | | |
|------|-------------|------|-------|---------------------------------|--|--|--|--|
| 15-0 | TP0_B[15:0] | R/W | 0h | Lower 16 bits of test pattern 0 | | | | |



7.2.8 Register 1Ah (offset = 1Ah) [reset = 0h]

| | Figure 7-29. Register 1Ah | | | | | | | | |
|--------------|---------------------------|---|-----|------|---|---|---|--|--|
| 15 | 5 14 13 12 11 10 9 8 | | | | | | | | |
| | TP1_B[7:0] | | | | | | | | |
| | R/W-0h | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| TP0_B[23:16] | | | | | | | | | |
| | | | R/W | /-0h | | | | | |

Figure 7-30. Register 1Ah Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------|------|-------|------------------------------------|
| 15-8 | TP1_B[7:0] | R/W | 0h | Lower eight bits of test pattern 1 |
| 7-0 | TP0_B[23:16] | R/W | 0h | Upper eight bits of test pattern 0 |

7.2.9 Register 1Bh (offset = 1Bh) [reset = 0h]

| | Figure 7-31. Register 1Bh | | | | | | | | |
|----|---------------------------|--------------------|-----|------|---|---|---|--|--|
| 15 | 14 | 14 13 12 11 10 9 8 | | | | | | | |
| | TP1_B[23:8] | | | | | | | | |
| | R/W-0h | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | TP1_B[23:8] | | | | | | | | |
| | | | R/W | /-0h | | | | | |

| | Figure 7-32. Register 1Bh Field Descriptions | | | | | | | |
|------|--|-----|----|---------------------------------|--|--|--|--|
| Bit | Bit Field Type Reset Description | | | | | | | |
| 15-0 | TP1_B[23:8] | R/W | 0h | Upper 16 bits of test pattern 1 | | | | |

Register 1Ch (offset = 1Ch) [reset = 0h]

| | Figure 7-33. Register 1Ch | | | | | | | |
|------|---------------------------|-------------------|----|-----|------|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESE | RVED | USER_BITS_CH[8:5] | | | | | | |
| R/W | /-0h | R/W-0h | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESE | RVED | USER_BITS_CH[4:1] | | | | | | |
| R/W | /-0h | | | R/W | /-0h | | | |

Figure 7-34. Register 1Ch Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------------------|------|-------|---|
| 15-14 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 13-8 | USER_BITS_CH[8:5] | R/W | 0h | User-defined bits appended to the ADC conversion result from channels 5, 6, 7, and 8. |
| 7-6 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 5-0 | USER_BITS_CH[4:1] | R/W | 0h | User-defined bits appended to the ADC conversion result from channels 1, 2, 3, and 4. |

Copyright © 2024 Texas Instruments Incorporated



7.2.10 Register 37h (offset = 37h) [reset = 0h]

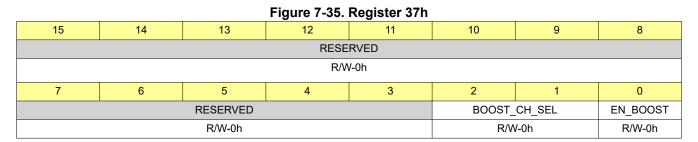


Figure 7-36. Register 37h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------|------|-------|--|
| 15-3 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 2-1 | BOOST_CH_SEL | R/W | 0h | Select analog input channel pair for speed-boost mode. 0: CH1 and CH8 1: CH2 and CH7 2: CH3 and CH6 3: CH4 and CH5 |
| 0 | EN_BOOST | R/W | 0h | Enable speed-boost mode. See section on <i>Speed-Boost Mode</i> for more details. |

7.2.11 Register 3Ch (offset = 3Ch) [reset = 0h]

| | Figure 7-37. Register 3Ch | | | | | | | | |
|----------|---------------------------|----|----|----------|----|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | RESERVED | | | | | | | | |
| | R/W-0h | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| AVG_CFG3 | | | • | RESERVED | | | • | | |
| R/W-0h | | | | R/W-0h | | | | | |

| Figure 7-38. Register 3Ch Field Descriptions | | | | | | | | | |
|--|----------|------|-------|--|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | | |
| 15-8 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. | | | | | |
| 7 | AVG_CFG3 | R/W | 0h | Configuration for simple averaging. See Table 6-10 for more details. | | | | | |
| 6-0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. | | | | | |

Figure 7-38. Register 3Ch Field Descriptions



7.2.12 Register 92h (offset = 92h) [reset = 0h]

| | Figure 7-39. Register 92h | | | | | | | | | |
|----|---------------------------|------|------|----|----|--------|----------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | RESERVED | | | | | | | | | |
| | R/W-0h | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | | RESE | RVED | | | INIT_2 | RESERVED | | | |
| | | R/W | /-0h | | | R/W-0h | R/W-0h | | | |

Figure 7-40. Register 92h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------|------|-------|--|
| 15-2 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 1 | INIT_2 | R/W | 0h | Set to 1b for normal operation. Refer to section on <i>Initialization Sequence</i> for more details. |
| 0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |

7.2.13 Register C0h (offset = C0h) [reset = 0h]

| Figure 7-41. Register C0h | | | | | | | | | | |
|---------------------------|----|-----|--------|----|----|--------|------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | | | ANA_BW | | | | | | | |
| | | R/W | /-0h | | | R/W-0h | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | | ANA | BW | | | PD_CH | | | | |
| | | R/W | /-0h | | | R/W | /-0h | | | |

Figure 7-42. Register C0h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------|------|-------|--|
| 15-10 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 9-2 | ANA_BW | R/W | 0h | Select analog input bandwidth for the respective analog input channels. MSB = BW control for channel 8 LSB = BW control for channel 1 0 : Low-noise mode 1 : Wide-bandwidth mode |
| 1-0 | PD_CH | R/W | 0h | Power-down control for the analog input channels. 0 : Normal operation 1 : Channels 5, 6, 7, and 8 powered down 2 : Channels 1, 2, 3, and 4 powered down 3 : All channels powered down |



7.2.14 Register C1h (offset = C1h) [reset = 0h]

| | Figure 7-43. Register C1h | | | | | | | | | | |
|----|---------------------------|------|-----|--------|----------|------------|-----------|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESE | RVED | | PD_REF | RESERVED | DATA_LANES | DATA_RATE | | | | |
| | R/M | V-0h | | R/W-0h | R/W-0h | R/W-0h | R/W-0h | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | RESERVED | | | | | | | | | | |
| | | | R/W | /-0h | | | | | | | |

Figure 7-44. Register C1h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|------------|------|-------|---|
| 15-12 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 11 | PD_REF | R/W | 0h | ADC reference voltage source selection.0 : Internal reference enabled.1 : Internal reference disabled. Connect the external reference voltage to the REFIO pin. |
| 10 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 9 | DATA_LANES | R/W | 0h | Select number of output data lanes per ADC channel. 0 : 4-lane mode. CH[4:1] data are output on pins D3 and D2. CH[8:5] data are output on pins D1 and D0. 1 : 2-lane mode. CH[4:1] data are output on pin D3. CH[8:5] data are output on pin D1. |
| 8 | DATA_RATE | R/W | 0h | Select data rate for the data interface. 0 : Double data rate (DDR) 1 : Single data rate (SDR) |
| 7-0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |

7.2.15 Register C2h (offset = C2h) [reset = 0h]

Figure 7-45. Register C2h

| | | | | U | | | |
|----|------|-------|----|-----------|----|---|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RANG | E_CH4 | | RANGE_CH3 | | | |
| | R/W | V-0h | | R/W-0h | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | RANG | E_CH2 | | RANGE_CH1 | | | |
| | R/W | V-0h | | R/W-0h | | | |

| Bit | Field | Туре | Reset | Description |
|-------|-----------|------|-------|--|
| 15-12 | RANGE_CH4 | R/W | 0h | Select the analog input voltage range. |
| 11-8 | RANGE_CH3 | R/W | 0h | 0 : ±5V 1 : ±3.5V |
| 7-4 | RANGE_CH2 | R/W | 0h | 2 : ±2.5V |
| 3-0 | RANGE_CH1 | R/W | Oh | 3 : ±7V 4 : ±10V 5 : ±12V |



7.2.16 Register C3h (offset = C3h) [reset = 0h]

| | Figure 7-47. Register CSI | | | | | | | | | |
|----|---------------------------|-------|----|-----------|-----|------|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 10 9 8 | | | | | | |
| | RANG | E_CH8 | | RANGE_CH7 | | | | | | |
| | R/M | V-0h | | R/W-0h | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | RANG | E_CH6 | | RANGE_CH5 | | | | | | |
| | R/V | V-0h | | | R/V | V-0h | | | | |

Figure 7-47. Register C3h

Figure 7-48. Register C3h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------|------|-------|--|
| 15-12 | RANGE_CH8 | R/W | 0h | Select the analog input voltage range. |
| 11-8 | RANGE_CH7 | R/W | 0h | 0 : ±5V 1 : ±3.5V |
| 7-4 | RANGE_CH6 | R/W | 0h | 2 : ±2.5V |
| 3-0 | RANGE_CH5 | R/W | 0h | 3 : ±7V 4 : ±10V 5 : ±12V |

Register C4h (offset = C4h) [reset = 0h]

| | Figure 7-49. Register C4h | | | | | | | | | |
|--------|---------------------------|--------|------|--------|-------------------|----------|---------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | RESERVED CM_RNG_CH[8:5] | | | | | | | | | |
| | | R/W-0h | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| CM_RNG | CM_RNG_CH[4:1] AVG_CFG2 | | | | CM_EN_ CH[4:1] | AVG_CFG1 | PD_CHIP | | | |
| R/V | V-0h | R/W | /-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | | | |

Figure 7-50. Register C4h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------|------|-------|--|
| 15-10 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 9-8 | CM_RNG_CH[8:5] | R/W | 0h | CM_RNG_CH[4:1] sets the common-mode range for |
| 7-6 | CM_RNG_CH[4:1] | R/W | Oh | channels 1, 2, 3, and 4. CM_RNG_CH[8:5] sets the common-mode range for channels 5, 6, 7, and 8. 0 : CM range is equal to ±RANGE / 2 1 : CM range is equal to ±6V 2 : CM range is equal to ±12V |
| 5-4 | AVG_CFG2 | R/W | 0h | Configuration for simple averaging. See Table 6-10 for more details. |
| 3 | CM_EN_CH[8:5] | R/W | 0h | CM_EN_CH[4:1] enables wide common-mode range |
| 2 | CM_EN_CH[4:1] | R/W | 0h | control for channels 1 to 4. CM_EN_CH[8:5] enables the wide common-mode range control for channels 5 to 8. 0 : Wide common-mode range control disabled 1 : Wide common-mode range control enabled |
| 1 | AVG_CFG1 | R/W | 0h | Configuration for simple averaging. See Table 6-10 for more details. |
| 0 | PD_CHIP | R/W | 0h | Full chip power-down control. 0 : Normal device operation 1 : Full device powered-down |

Copyright © 2024 Texas Instruments Incorporated



7.2.17 Register C5h (offset = C5h) [reset = 0h]

| 15 | 14 | 13 12 11 | | | 10 | 9 | 8 | | |
|----------|----------------------------|----------|------------|------------|-----------|-----------|----------|--|--|
| BOOST | BOOST_CFG1 RESERVED INIT_3 | | | | INIT_3 | PGA_INIT2 | RESERVED | | |
| R/W | V-0h | | R/W-0h | | R/W-0h | R/W-0h | R/W-0h | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| RESERVED | AVG_ | CFG4 | CM_CTRL_EN | BOOST_CFG2 | PGA_INIT2 | RESE | RVED | | |
| R/W-0h | R/V | V-0h | R/W-0h | R/W-0h | R/W-0h | R/W | /-0h | | |

Figure 7-51. Register C5h

Figure 7-52. Register C5h Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|------------|------|-------|---|
| 15-14 | BOOST_CFG1 | R/W | 0h | Configuration for speed-boost mode. See Table 6-15 for more details. |
| 13-11 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 10 | INIT_3 | R/W | Oh | Set to 1 for normal operation. Refer to <i>Initialization</i> Sequence for more details. |
| 9 | PGA_INIT2 | R/W | 0h | Conifguration for PGA initialization. Set to 1 for normal operation. Refer to <i>Initialization Sequence</i> for more details. |
| 8-7 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |
| 6-5 | AVG_CFG4 | R/W | 0h | Configuration for simple averaging. See Table 6-10 for more details. |
| 4 | CM_CTRL_EN | R/W | 0h | Enable the wide common-mode range control for all analog input channels. 0 : CM range for all analog input channels is ±12V 1 : CM range is user-defined in the CM_EN_CH[4:1], CM_EN_CH[8:5], CM_RNG_CH[4:1], and CM_RNG_CH[8:5] registers |
| 3 | BOOST_CFG2 | R/W | 0h | Configuration for speed-boost mode. See Table 6-15 for more details. |
| 2 | PGA_INIT1 | R/W | Oh | Conifguration for PGA initialization. Set to 1 for normal operation. Refer to <i>Initialization Sequence</i> for more details. |
| 1-0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. |



7.3 Register Bank 2

| | Figure 7-53. Register Bank 2 Map | | | | | | | | | | | | | | | |
|-----|----------------------------------|------|------|-----|----------------|------------|----|----|----|----|----|----|----|----|----|----|
| ADD | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 25h | | RESE | RVED | - | BOOST_ CFG4 | - RESERVED | | | | | | | | | | |

Table 7-3. Register Section/Block Access Type Codes

| Access Type | Code | Description |
|------------------------|------|--|
| R | R | Read |
| W | W | Write |
| R/W | R/W | Read or write |
| Reset or Default Value | | |
| -n | | Value after reset or the default value |

7.3.1 Register 25h (offset = 25h) [reset = 0h]

| Figure 7-54. Register 25h | | | | | | | | | | |
|---------------------------|----------|------|-----|------------|----------|------------|----------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | RESE | RVED | | BOOST_CFG4 | RESERVED | BOOST_CFG3 | RESERVED | | | |
| | R/W | /-0h | | R/W-0h | R/W-0h | R/W-0h | R/W-0h | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | RESERVED | | | | | | | | | |
| | | | R/V | V-0h | | | | | | |

Figure 7-55. Register 25h Field Descriptions

| ······································ | | | | | | | | |
|--|------------|------|-------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 15-12 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. | | | | |
| 11 | BOOST_CFG4 | R/W | 0h | Configuration for speed-boost mode. See Table 6-15 for more details. | | | | |
| 10 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. | | | | |
| 9 | BOOST_CFG3 | R/W | 0h | Configuration for speed-boost mode. See Table 6-15 for more details. | | | | |
| 8-0 | RESERVED | R/W | 0h | Reserved. Do not change from the default reset value. | | | | |



8 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

8.1 Application Information

The ADS9813 enables high-precision measurement of up to eight analog signals. The following section gives an example application circuit and recommendations for using the ADS9813 in automated test equipment (ATE) systems.

8.2 Typical Application

8.2.1 Parametric Measurement Unit (PMU)

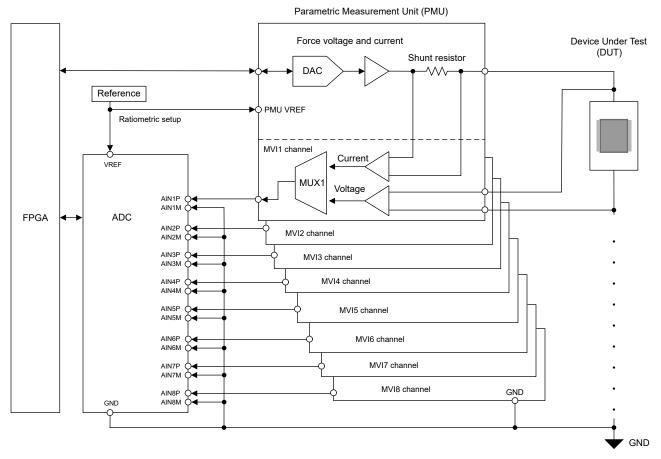


Figure 8-1. Typical PMU



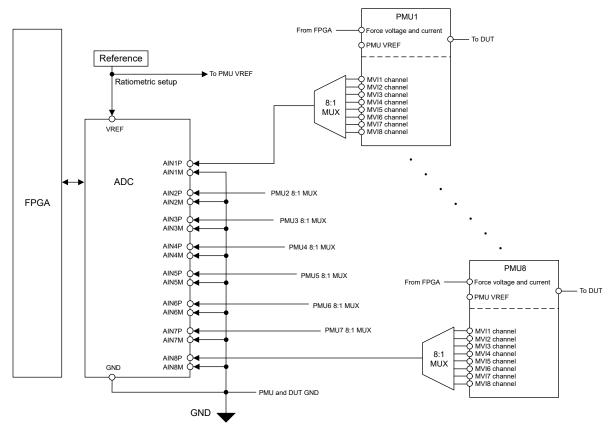


Figure 8-2. PMU With a Multiplexer

8.2.2 Design Requirements

The goal of this application is to select an ADC for ATE applications. Table 8-1 shows the parameters for this design example.

| PARAMETER | VALUE | | | | | | |
|---|---|--|--|--|--|--|--|
| Sampling rate | Up to 2MSPS/channel | | | | | | |
| Total unadjusted error (TUE) over 25°C ±5°C | <0.01% with calibration | | | | | | |
| Supports external switches or multiplexer | Full-scale step settling to 99.95% of full-scale in <10µs | | | | | | |

Table 8-1. Design Parameters



8.2.3 Detailed Design Procedure

The ADS9813 is an eight-channel, 18-bit, 2MSPS data acquisition (DAQ) system. The device has a built-in analog front-end that makes the ATE signal chain easier to design and more accurate.

The ADC accuracy is based on the total-unadjusted-error (TUE), which combines INL, offset, and gain errors. Calibrate the external system for offset and gain errors at a specified temperature and supply voltage. When calibrated (as described in Table 8-2), only the INL, thermal offset drifts, and gain contribute to TUE. The ADS9813 has a TUE of 0.0015% at 25°C \pm 5°C post-calibration, meeting the design error requirement.

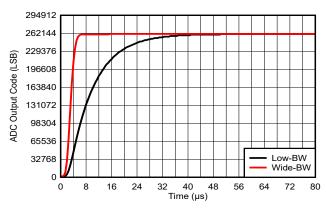
| | | A | | | |
|-----------------------|-----------|--------------------|------------------|-----------|-----------|
| CALIBRATION | INL (ppm) | OFFSET ERROR (ppm) | GAIN ERROR (ppm) | TUE (ppm) | ERROR (%) |
| No calibration | ±3.2 | ±60 | ±80 | ±100.05 | ±0.0100 |
| Post-calibration | ±3.2 | 0 | 0 | ±3.2 | ±0.0003 |
| Post-calibration ±5°C | ±3.2 | ±7.5 | ±12.5 | ±14.92 | ±0.0015 |

Table 8-2. TUE at T_{Δ} = 25°C Calculation for RANGE = ±5V

The pin-electronics subsystem manages the PMU outputs. The subsystem connects each PMU output to separate ADC channels (Figure 8-1) or uses a multiplexer to link multiple PMU outputs to one ADC channel (Figure 8-2). This subsystem allows more pin-electronics channels on the card. The ADC requires more bandwidth with multiplexers (Table 8-3) for fast settling when switching PMU channels. The ADS9813 has two bandwidth modes: Low-noise (up to 22.7kHz) and wide-bandwidth (up to 700kHz). As described in Figure 8-3 the wide-bandwidth mode samples multiplexed PMU signals and settles to 99.95% FS in 7.5µs.

Table 8-3. Step-Settling Performance for RANGE = $\pm 5V$

| ANALOG INPUT BANDWIDTH | SETTLING TIME (99.95% of FS) | SNR (Typical) | | | | | | |
|------------------------|------------------------------|---------------|--|--|--|--|--|--|
| Low BW (22.7kHz) | 55µs | 89.1dB | | | | | | |
| Wide BW (500kHz) | 7.5µs | 79.7dB | | | | | | |



8.2.4 Application Curve

Figure 8-3. Step-Settling Performance



8.3 Power Supply Recommendations

The ADS9813 has three separate power supplies: AVDD_5V, VDD_1V8, and IOVDD. There is no requirement for a specific power-up sequence. The data and configuration digital interfaces are powered by IOVDD. A common 1.8V supply powers the VDD_1V8 and IOVDD pins. Figure 8-4 illustrates the decoupling capacitor connections for the respective power supplies. Make sure each power-supply pin has separate decoupling capacitors.

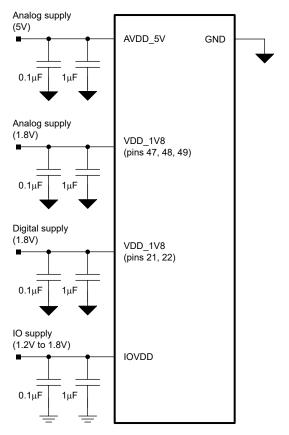


Figure 8-4. Power-Supply Decoupling



8.4 Layout

8.4.1 Layout Guidelines

Figure 8-5 illustrates a board layout example for the ADS9813. Avoid crossing digital lines with the analog signal path and keep the analog input signals and the reference signals away from noise sources.

Use 0.1µF ceramic bypass capacitors in close proximity to the AVDD_5V, VDD_1V8, and IOVDD power-supply pins. Avoid placing vias between the power-supply pins and the bypass capacitors.

Place the reference decoupling capacitor close to the device REFIO and REFM pins. Avoid placing vias between the REFIO pin and the bypass capacitors. Connect the GND and REFM pins to a ground plane using short, low-impedance paths.

8.4.2 Layout Example

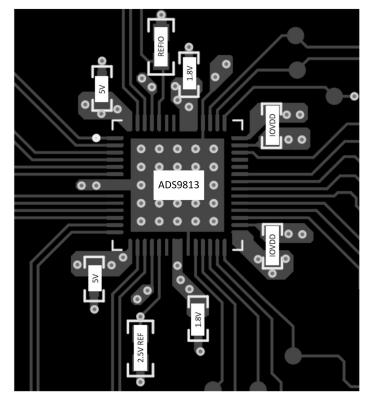


Figure 8-5. Example Layout



9 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

9.2 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

9.3 Trademarks

TI E2E[™] is a trademark of Texas Instruments. All trademarks are the property of their respective owners.

9.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

9.5 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| С | hanges from Revision * (April 2024) to Revision A (November 2024) | Page |
|---|---|------|
| • | Changed the document from Advanced information to Production data | 1 |

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|----------------------|--------------|-------------------------|---------|
| ADS9813RSHR | ACTIVE | VQFN | RSH | 56 | 4000 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS9813 | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



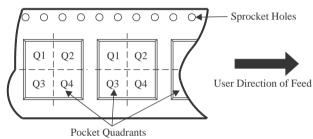
www.ti.com

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | |
|-----------------------------|--|
| | |

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| ADS9813RSHR | VQFN | RSH | 56 | 4000 | 330.0 | 16.4 | 7.3 | 7.3 | 1.1 | 12.0 | 16.0 | Q2 |



www.ti.com

PACKAGE MATERIALS INFORMATION

7-Dec-2024



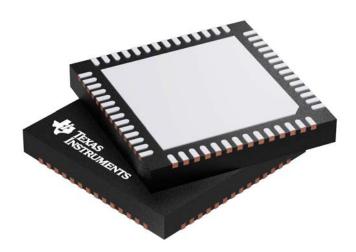
*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS9813RSHR | VQFN | RSH | 56 | 4000 | 367.0 | 367.0 | 35.0 |

GENERIC PACKAGE VIEW

VQFN - 1 mm max height

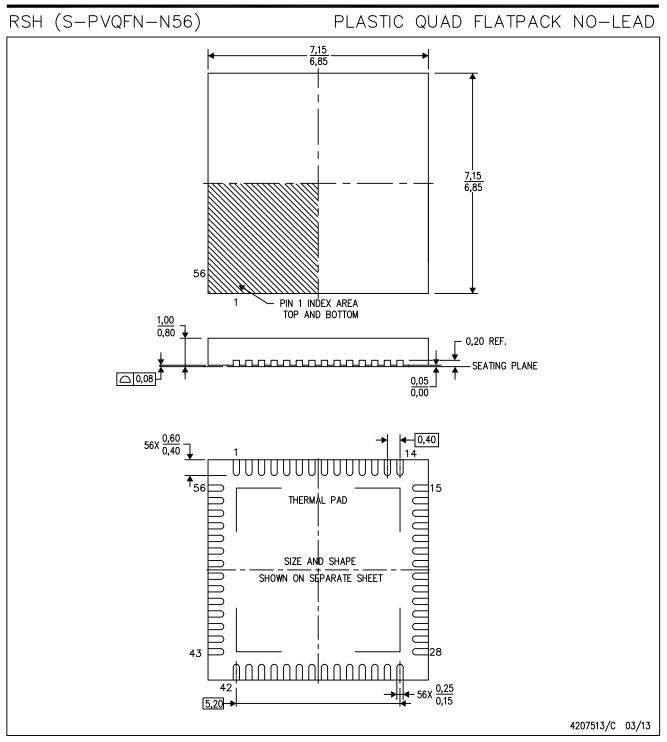
PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



MECHANICAL DATA



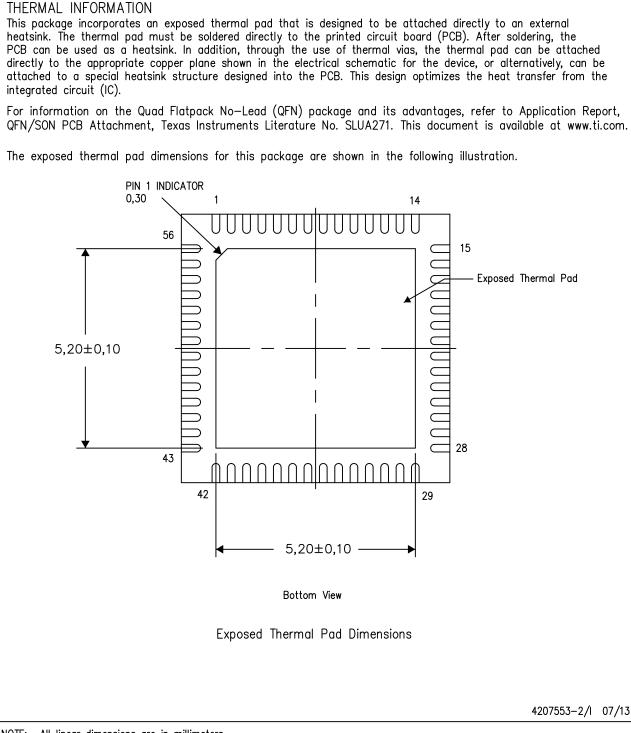
NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Quad Flatpack, No-leads (QFN) package configuration.
- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.



RSH (S-PVQFN-N56)

PLASTIC QUAD FLATPACK NO-LEAD

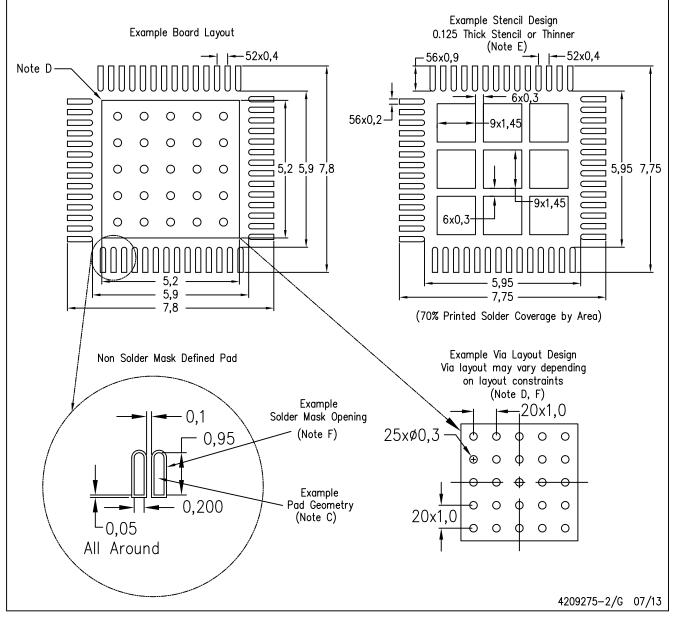


NOTE: All linear dimensions are in millimeters



RSH (S-PVQFN-N56)

PLASTIC QUAD FLATPACK NO-LEAD



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http://www.ti.com>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for vias placed in the thermal pad.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024, Texas Instruments Incorporated